

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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Renesas

USB Device



EQUSB

Easy, high quality USB

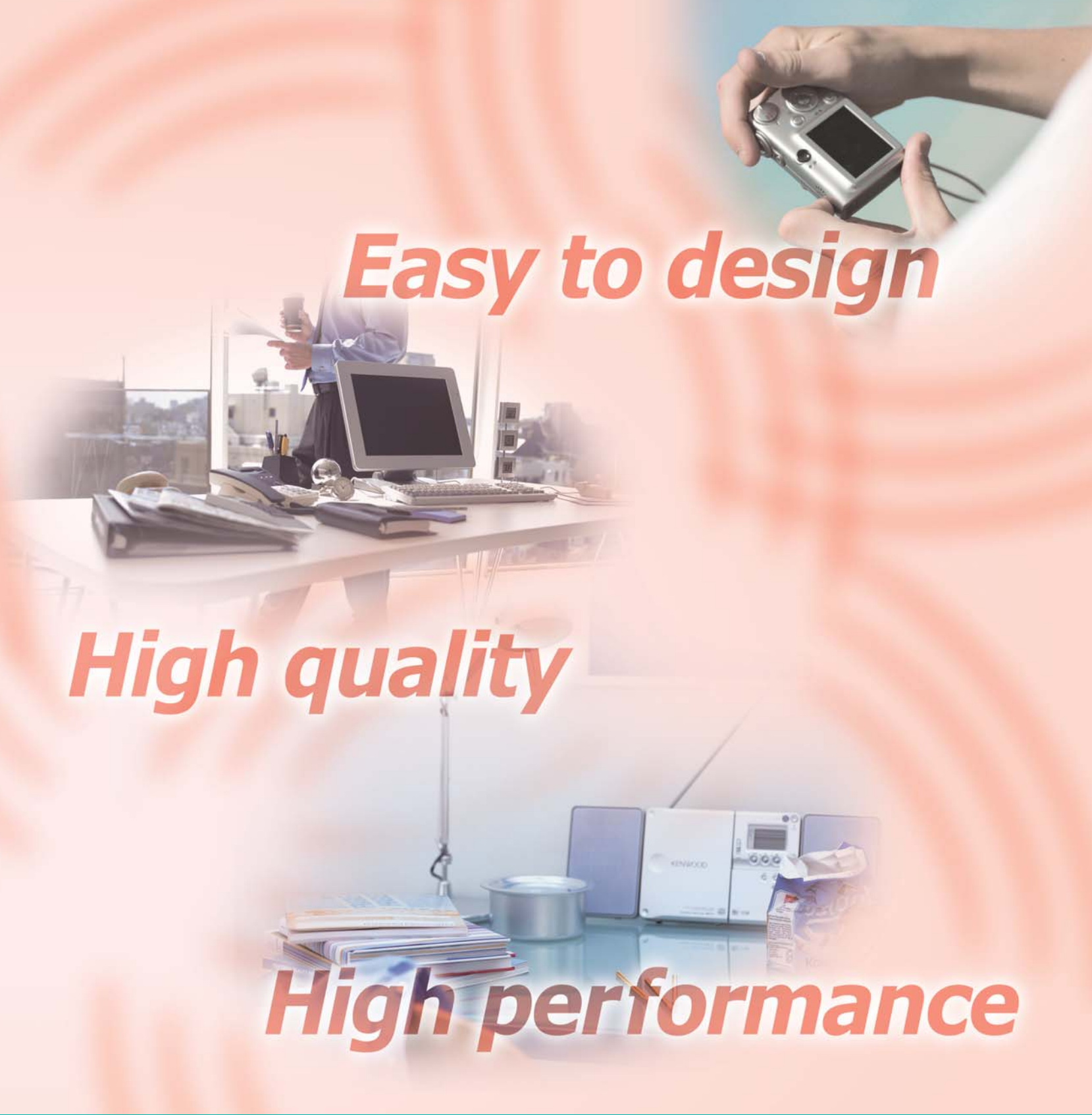
State-of-the-art technologies of the Renesas <EqUSB> support the future of society.

The USB specification established to connect the PC peripheral equipment is currently used for a number of different products in various scenarios, such as office equipment, mobile devices, AudioVideo equipment, and industrial equipment.

For topical On-The-Go, Embedded Host, and advanced Wireless USB, Renesas continues to provide you with the ideal USB devices to meet customer needs.

EqUSB

Easy, high quality USB



Easy to design

High quality

High performance

Easy to design

A wide variety of lineup from wired USB to wireless USB allows easy design of devices, which are so user-friendly.

High quality

The Renesas <EqUSB> passed USB Compliance Program. It has been already used in a wide variety of USB embedded products in the market.

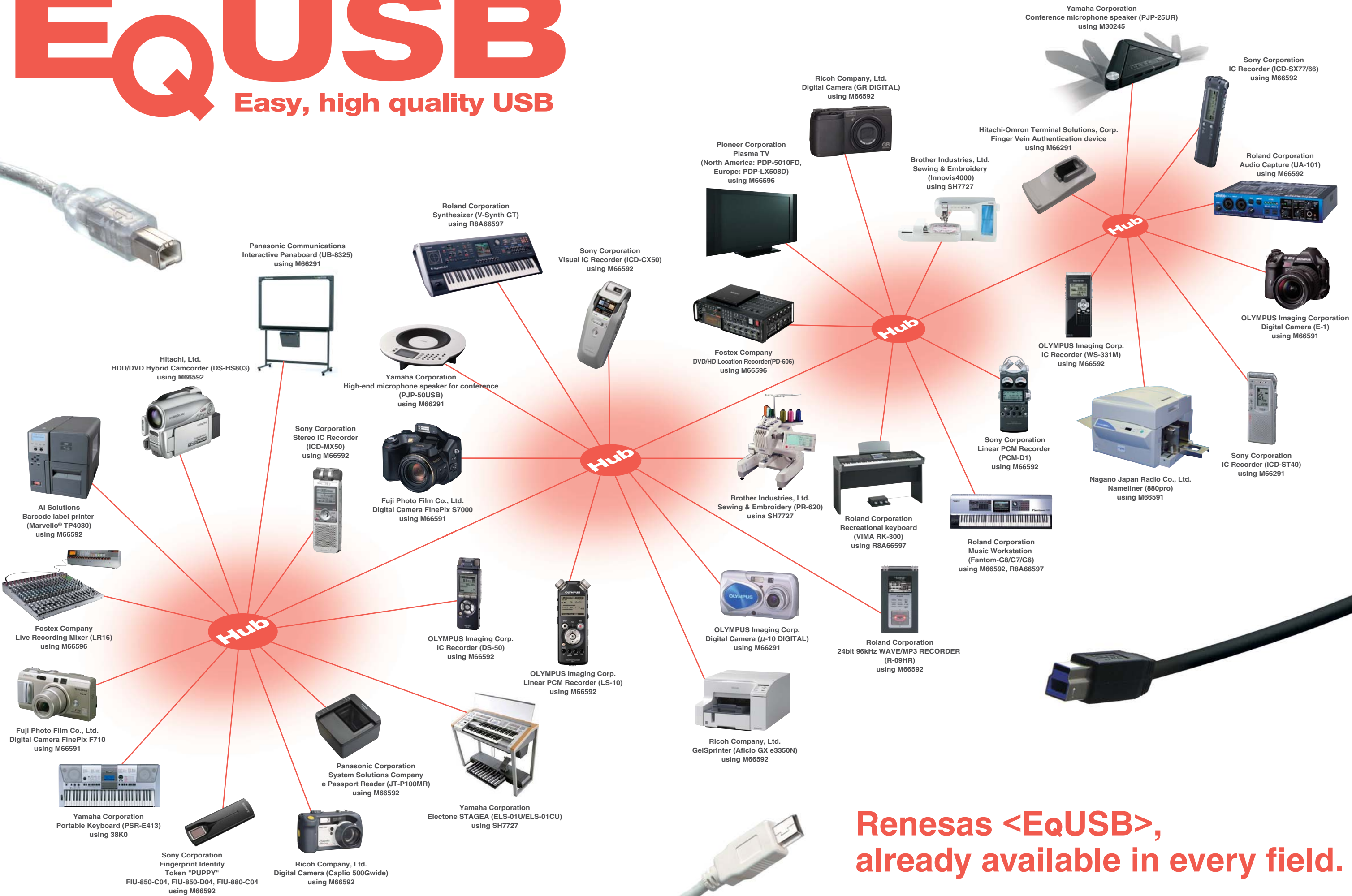
High performance

The original IP library of the Renesas <EqUSB> allows customers to select the most suitable system. Its excellent development environment and our powerful alliances with various partner vendors fully support your system development.

Road Map	Peripheral	Host
Wireless USB	<ul style="list-style-type: none"> Wireless USB ASSP Wireless USB-IP 	
Hi-Speed USB2.0	<ul style="list-style-type: none"> USB ASSP 32bit MCU SuperH Family USB-IP 	<ul style="list-style-type: none"> USB ASSP 32bit MCU SuperH Family USB-IP
Full-Speed USB2.0	<ul style="list-style-type: none"> USB ASSP 32bit MCU SuperH Family 32/16/8bit MCU H8SX/H8S/M16C/740 Family USB-IP 	<ul style="list-style-type: none"> 32bit MCU SuperH Family USB-IP

EqUSB

Easy, high quality USB



Renesas <EqUSB>, already available in every field.

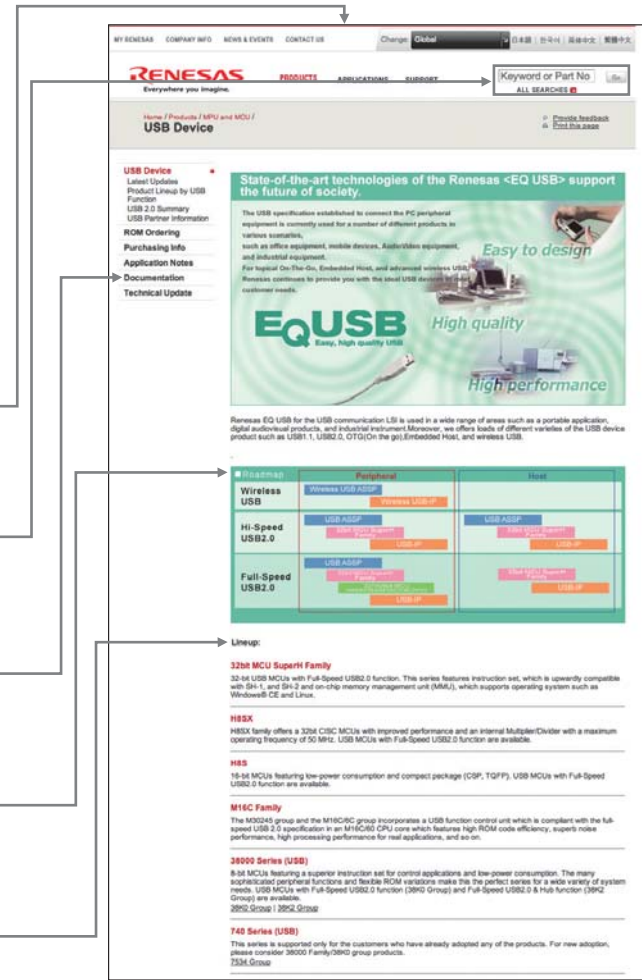
Various Renesas USB device

Renesas USB device Website

We will comprehensively support customer's development with rich development support information.

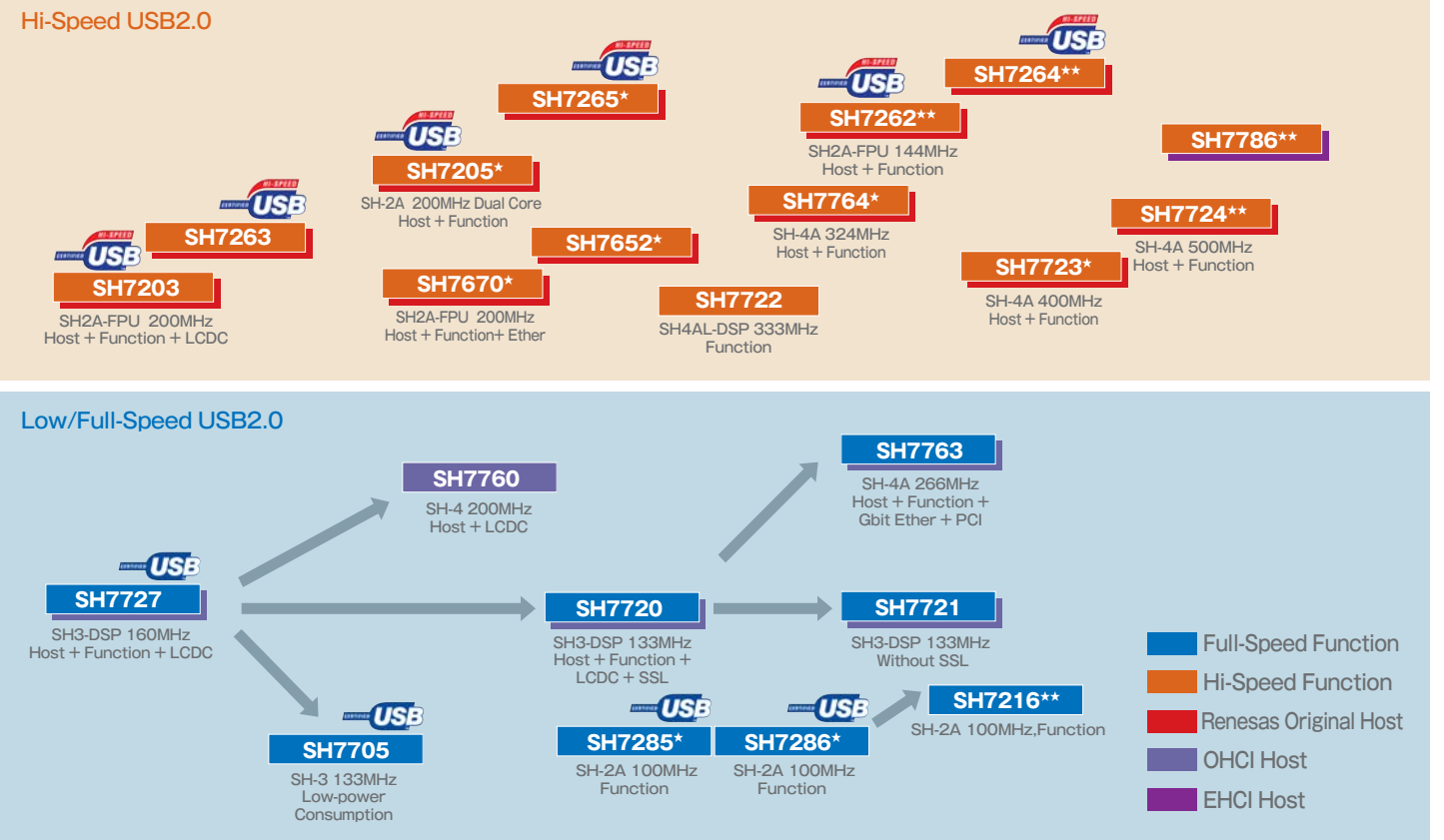
<http://www.renesas.com/en/usb>

- Contact** Please use this contact information for technical inquiries, etc.
- Various searches** Please use the various search functions.
- Document** The hardware manual, the software manual, etc., are available for download.
- Product expansion** Information regarding each device can be accessed from the expansion plan, too.
- Lineup** Relevant documents, such as application notes, etc., in addition to the product specifications of each device, are also available for downloading.



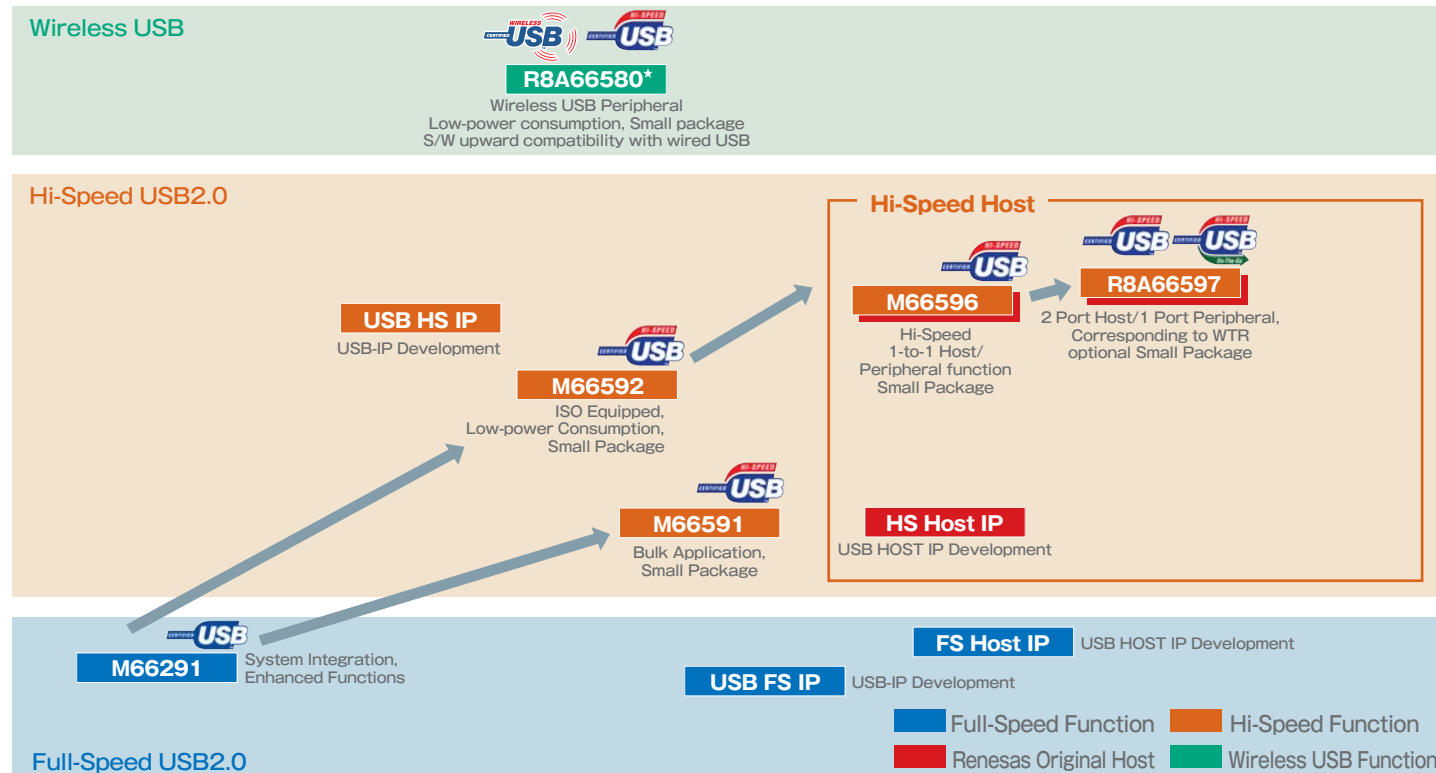
USB MCU Road Map (SuperH Family)

★:New product ★★:Under development



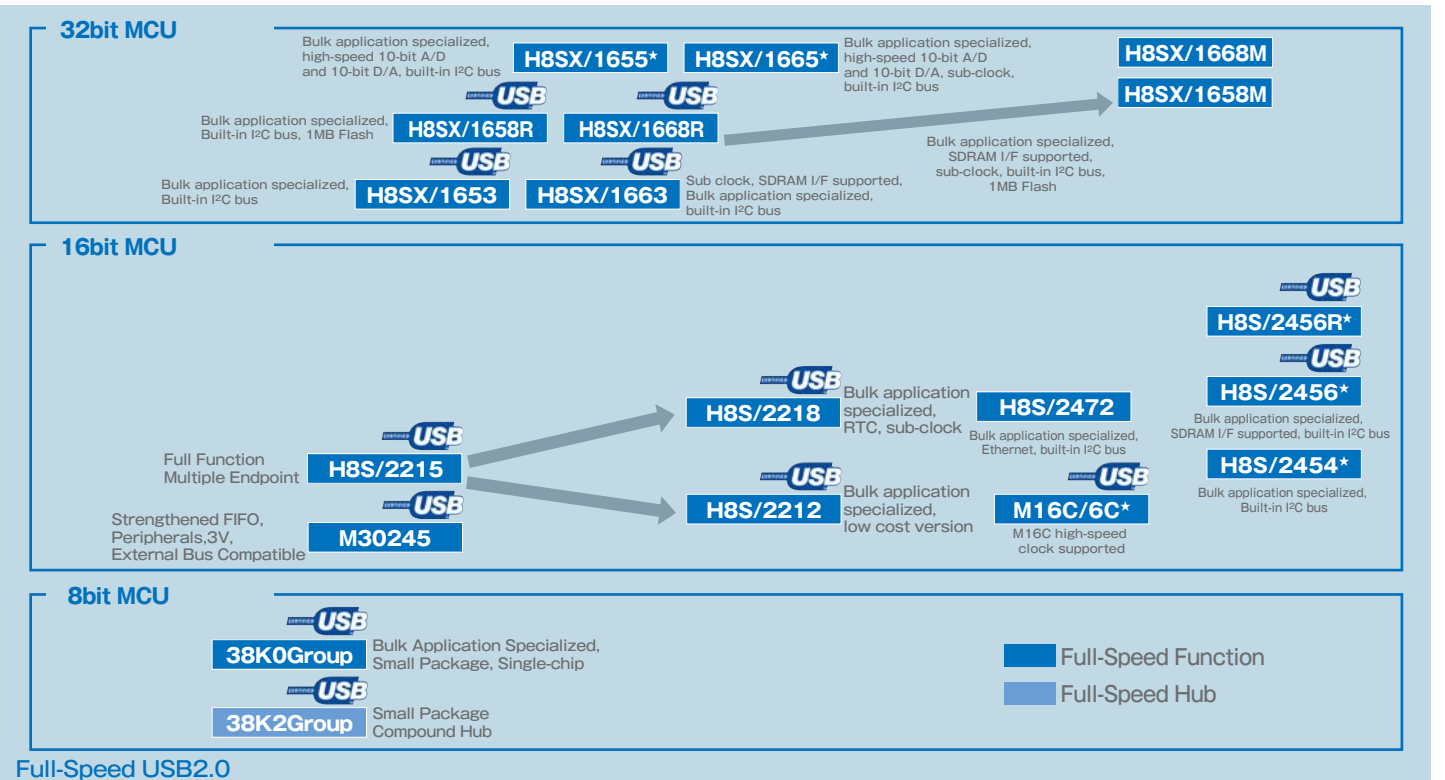
USB ASSP Road Map

★:New product











USB MCU Road Map (M16C, H8SX, H8S, 740 Family)

★:New product



RENESAS USB DEVICE PRODUCT LINEUP

Optimum devices are prepared for various applications.

							
Mobile device	Digital AV equipment	Electronic music instrument	PC peripheral equipment	OA equipment	Communication equipment	Industrial instrument	Car accessory
Cellular phone Portable audio device DSC/DVC Photo frame Portable navigation system IC recorder Electronic datebook PDA	Flat-screen television HDD recorder Set-top box Home server Audio compo DVD player	Electronic keyboard Electronic piano Synthesizer	Card reader Printer Scanner PC monitor	Facsimile Copy machine Complex machine Projector Electronic blackboard Interactive teleconference system TV conference system	Modem IT terminal IP telephone	POS system Barcode reader ATM Vending machine FA equipment Monitoring camera Camera application	Car navigation system Car audio system

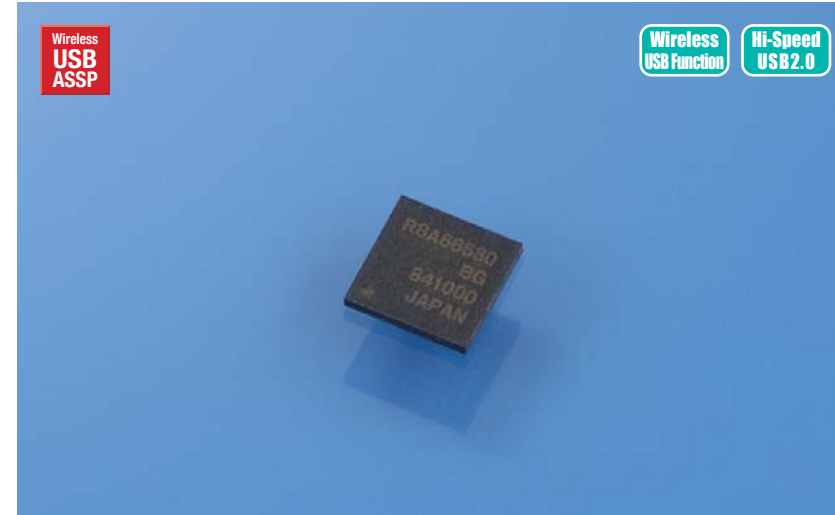
■ : Optimum model ■ : Supported model

EQUSB

Easy, high quality USB

Wireless USB Function

R8A66580BG



Supported application

- Mobile device
- Digital AV equipment
- Electronic music instrument
- PC peripheral equipment
- OA equipment
- Communication equipment
- Industrial instrument
- Car accessory

Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
R8A66580BG ★	100	LFBGA	PLBG0100KA-A	3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	TBD

*1. One stage of an external HUB can be connected (When the Full-Speed function is connected via Hi-Speed hub, the payload of Isochronous corresponds to 188 bytes or less.)
 *2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO. ★: New product

The R8A66580 is the controller suitable for embedded application, which directly changes the existing wired USB product to the wireless USB product.

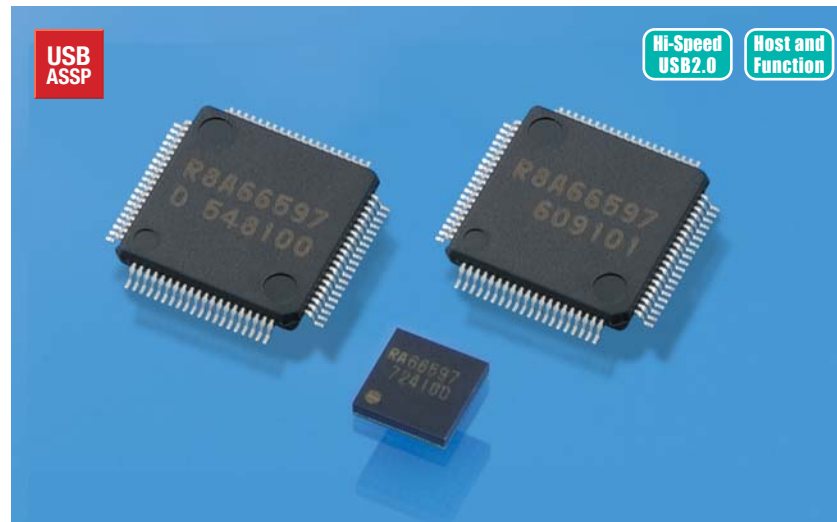
The R8A66580 is a peripheral function controller compliant with "Wireless USB Specification Rev.1.0". It can perform the wireless communication by combining with "MAC-PHY interface Specification Ver.1.2" compliant PHY chip. The features of the R8A66580 are ultra-low power consumption and ultra-small package (5.5mm X 5.5mm). It is suitable for the compact size and battery-driven products such as DSC and portable player etc.. The R8A66580 succeeds the design architecture of Renesas's USB controllers to ensure the compatibility.

Block diagram

Wireless USB ASSP WireMedia MAC standard 1.0-compliant Self Beaconing Device	Split Bus 8-bit split bus I/F	Wireless USB Transmission rate 53.3/80/110.7/140/200/320/400/480Mbps
UWB PHY I/F WireMedia MAC-PHY Interface standard 1.2-compliant	Power Source for USB Pull-up D+ Pull-up Power Source (Supply Control)	USB Host *1 1 port
Encryption AES-128CCM support by H/W	PLL Frequency Multiplier Built-in	USB Function *2 1 port
External PHY Resume Input Terminal 1 (LWB PHY resume by an external terminal)	Interrupt Pin 1-pin polarity set, interrupt source can be assigned	Speed HS/FS (USB) LS (USB Host only)
Clock Input Frequency 12MHz	Vbus Detector USB cable connection/disconnection detector	FIFO 32K (Total)*3 (Wireless USB) 2K (MAX)*3 16K (Total)*4 (USB)
DMA Interface 2ch (1ch:Used for both Internal and external)	Built-in Resistor D+, D- Termination Resistor (In Host Mode) D+, D- Pull-down Resistor (In Peripheral Mode)	Endpoint (Pipe) 8 Endpoints (Wireless USB) 10 Endpoints (USB)
Bus Interface 16-bit separate CPU bus I/F	Low-Power Sleep State S/W Settable	Isynchronous Transfer Supported (USB only)

- ROAD MAP
- SELECTION MAP
- R8A66580
- R8A66597
- M66592/M66591
- M66592/M66591
- SH7724/SH7722/SH7723
- SH7724/SH7723
- SH7265/SH7205/SH7203
- SH7205/SH7203
- SH7670/SH7674
- SH7216
- SH7285/SH7286
- SH7763/SH7760
- SH7720/SH7721/SH7705
- SH7720/SH7705
- H8SX/1665/1655
- H8SX/1665/1655
- H8SX/1653/1663/1654
- H8SX/1663/1654
- H8S/2212/H8S/2459R/2158/2154/2159/2454
- H8S/2212/H8S/2459R/2158/2154/2159/2454
- M30245
- M30245
- 3BK0/3BK2
- USB I/ I/ZENER DIODE
- DEVELOPMENT ENVIRONMENT
- EVALUATION PRODUCTS
- EVALUATION BOARD

Hi-Speed USB2.0 Host and Function R8A66597FP/DFP/BG



Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
R8A66597FP	80	LQFP	PLQP0080LA-A	3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:70 FS:25
R8A66597DFP	80	LQFP	PLQP0080LA-A	3.3	1.6 to 2.0/2.7 to 3.6	-40 to 85*	HS:70 FS:25
R8A66597BG	81	LFBGA	PLBG0081KA-A	3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:70 FS:25

*Wide temperature type
*1. One stage of an external HUB can be connected (When the Full-Speed function is connected via Hi-Speed hub, the pay load of Isochronous corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO.

The USB Host can be easily established. The USB memory, keyboard, mouse and multimedia device can be communicated with more than one USB device at the same time.

The R8A66597 is the USB controller that is the upper model of the M66596. It is possible to select either a host function (up to 2 ports) or 1 port peripheral function by this model's register settings. The host function enables the connection of an external HUB (up to one stage *) and communications for up to 10 devices. The Embedded Host can be easily realized and the function has been expanded so that the On-the-Go can be realized. In addition, it is now possible to incorporate a large variety of products thanks to the development of products that can tolerate a wide temperature range. This product has been developed using Renesas's original USB-IP, and it can be smoothly integrated into a System LSI.

Block diagram	USB Host *1	USB Function *2
Clock Input Frequency 12/24/48MHz	PLL Frequency Multiplier Built-in	USB Host *1 2 port
DMA Interface 2ch	Interrupt Pin 1-pin polarity set, interrupt source can be assigned	USB Function *2 1 port
Bus Interface 16-bit CPU Bus I/F, Separate/Multiplex selectable	Vbus Detector USB cable connection/disconnection detector	Speed HS/FS/LS (Host only)
Split Bus 8-bit Split Bus I/F	Built-in Resistor D+, D-Termination Resistor (In Host Mode) D+, D-Pull-down Resistor (In Host Mode) D+, Pull-up Resistor (In Peripheral Mode)	FIFO 2K (Max)*3 8.5K(Total)*4
Power Source for USB Pull-up D+ Pull-up Power Source (Supply Control)	Low-Power Sleep State S/W Settable	Endpoint (Pipe) 10 Endpoints
		Isochronous Transfer Supported

The M66596 can establish a simple and compact USB host system. It is suitable for the connection with a USB memory and a portable music player.

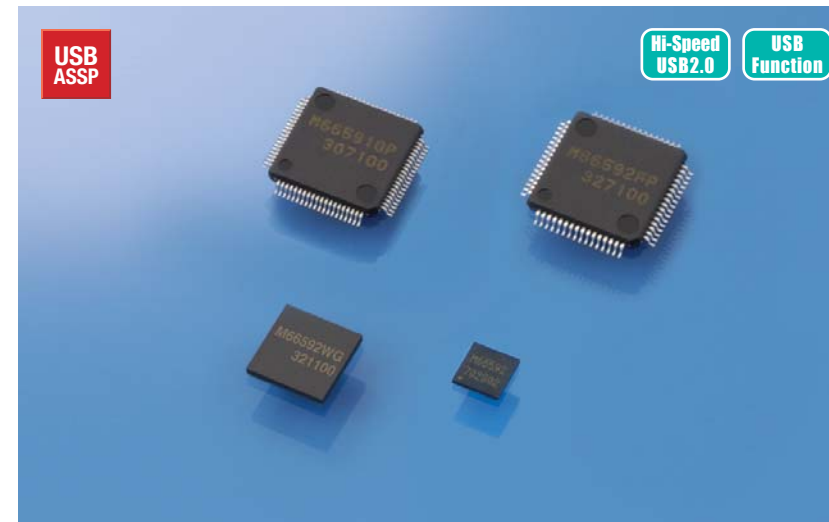
The M66596 is a USB controller conforming to USB2.0 specifications that are suitable for embedding applications. It is possible to select either a host function or peripheral function by this model's register settings. The Embedded Host can be easily realized and one-to-one high-speed transfer with USB peripheral occurs when the USB host function is selected. The development from the USB peripheral equipment to the USB host equipment can be easily implemented thanks to USB peripheral controller the M66592 and pin compatibility. This product has been developed using Renesas's original USB-IP, and it can be smoothly integrated into a System LSI.

Block diagram	USB Host	USB Function *1
Clock Input Frequency 12/24/48MHz	PLL Frequency Multiplier Built-in	USB Host 1 port
DMA Interface 2ch	Interrupt Pin 1-pin polarity set, interrupt source can be assigned	USB Function *1 1 port
Bus Interface 16-bit CPU Bus I/F, Separate/Multiplex selectable	Vbus Detector USB cable connection/disconnection detector	Speed HS/FS/LS (Host only)
Split Bus 8-bit Split Bus I/F	Built-in Resistor D+, D-Termination Resistor (In Host Mode) D+, D-Pull-down Resistor (In Host Mode) D+, Pull-up Resistor (In Peripheral Mode)	FIFO 2K (Max)*2 5K (Total)*3
Power Source for USB Pull-up D+ Pull-up Power Source (Supply Control)	Low-Power Sleep State S/W Settable	Endpoint (Pipe) 8 Endpoints
		Isochronous Transfer Supported

Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
M66596FP	64	LQFP	64P6X-B	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66596WG	64	FBGA	64FHX-A	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66596UG	64	VFBGA	64FHX-C	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18

*1. When the Function is used, the Host cannot be used. *2. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *3. Total number of built-in FIFO.

Hi-Speed USB2.0 Function M66592FP/WG/UG M66591GP



Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
M66592FP	64	LQFP	64P6X-B	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66592WG	64	FBGA	64FHX-A	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66592UG	64	VFBGA	64FHX-C	1.5/3.3	1.6 to 2.0/2.7 to 3.6	-20 to 85	HS:40 FS:18
M66591GP	80	LQFP	PLQP0080LA-A	3.3	1.7 to 2.0/2.7 to 3.6	-20 to 85	184

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. Total number of built-in FIFO.

Full-Speed USB2.0 Function M66291GP/HP



Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
M66291GP	48	LQFP	PLQP0048KB-A	3.3	2.7 to 3.6/4.5 to 5.5	-20 to 85	15
M66291HP	52	HVQFN	PVQN0052LA-B	3.3	2.7 to 3.6/4.5 to 5.5	-20 to 85	15

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. Total number of built-in FIFO.
*3. When I/O voltage=2.7 to 3.6V, clock input is 6/12/24/48MHz. When I/O voltage=4.5 to 5.5V, clock input is 24/48MHz.

Functions that cover video / music field in addition to small package and Bulk application are mounted. The industry leading class low power consumption is realized.

The M66591 and M66592 are Hi-Speed USB peripheral controllers complying with USB2.0 specifications. The M66592 furnishes low power consumption in an ultra small 5mm square package (M66592UG) that is suitable for mobile device applications. In addition, the 8-bit split (a DMA interface independent from the CPU bus) furnishes high-speed communications without stressing the CPU. These products has been developed using Renesas's original USB-IP and each can be smoothly integrated into a System LSI.

Block diagram	USB Function
Clock Input Frequency 12/24/48MHz	Interrupt Pin 1-pin polarity set, interrupt source can be assigned (M66592 Fix to polarity)
DMA Interface 2ch (M66592) 1ch (M66591)	Vbus Detector USB cable connection/disconnection detector
Bus Interface 16-bit CPU Bus I/F, Separate/Multiplex selectable	Built-in Resistor D+, D-Termination Resistor (M66592) D+, D-Pull-up Resistor (M66592)
Split Bus 8-bit Split Bus I/F	Low-Power Sleep State S/W Settable (M66592)
PLL Frequency Multiplier Built-in	Power Source for USB Pull-up D+ Pull-up Power Source (Supply Control)
	USB Power Management Output Function Configured Condition (M66591) Suspend Condition (M66591)
	FIFO 512K (Max)*1 3.5K (Total) *2 (M66591) 2K (Max)*1 5K (Total) *2 (M66592)
	Endpoint (Pipe) 7 Endpoints (M66591) 8 Endpoints (M66592)
	Isochronous Transfer Supported (M66592 only)

The industry leading class high-speed USB data communications are realized. The M66291 supports various Full-Speed USB product applications and realizes low power consumption.

The M66291 is a Full-Speed USB peripheral controller complying with USB2.0 specifications. It also flexibly supports a variety of DMA modes thanks to the built-in DMA interface (2-ch) and features selectable polarity. In addition, the M66291 comes equipped with 2 interrupt pins that enable the polarity settings, so various interrupt factors can be allocated freely. The connection to a CPU with a 5V power supply is available because the I/O power supply is 2.7 to 5.5V. This product has been developed using Renesas's original USB-IP, and it can be smoothly integrated into a System LSI.

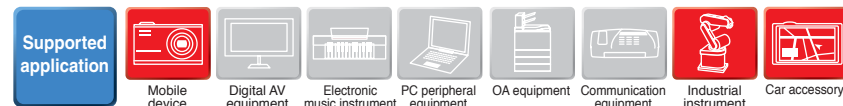
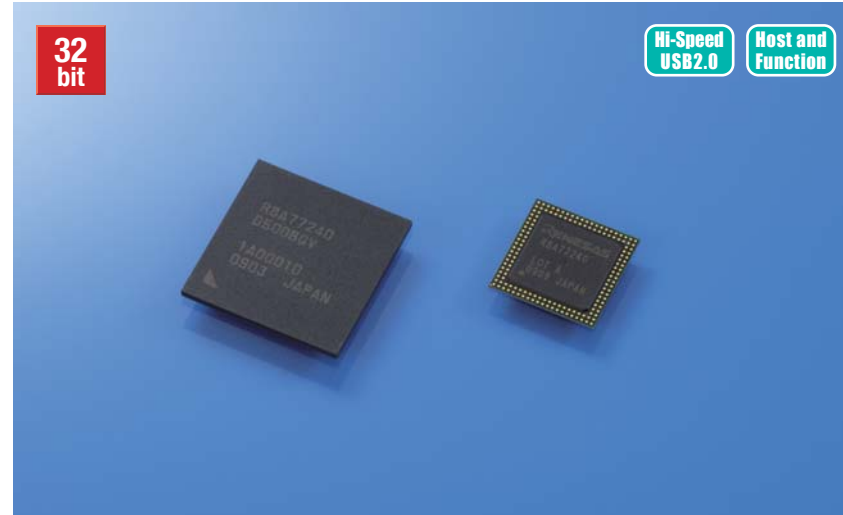
Block diagram	USB Function
Clock Input Frequency 6/12/24/48MHz *3	PLL Frequency Multiplier Built-in
DMA Interface 2ch polarity set, 8/16 bit correspondence	Interrupt Pin 2-pin polarity set, interrupt source can be assigned
Bus Interface 8/16 bit CPU	Vbus Detector USB cable connection/disconnection detector
Power Source for USB Pull-up D+ Pull-up Power Source (Supply Control)	FIFO 1K (Max)*1 3K (Total)*2
	Endpoint (Pipe) 7 Endpoints
	Isochronous Transfer Supported

Part Number	Pin	Package	Package Code	Supply Voltage (V)	I/O Voltage (V)	Operating Temperature (°C)	Current Consumption (mA)
M66291GP	48	LQFP	PLQP0048KB-A	3.3	2.7 to 3.6/4.5 to 5.5	-20 to 85	15
M66291HP	52	HVQFN	PVQN0052LA-B	3.3	2.7 to 3.6/4.5 to 5.5	-20 to 85	15

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. Total number of built-in FIFO.
*3. When I/O voltage=2.7 to 3.6V, clock input is 6/12/24/48MHz. When I/O voltage=4.5 to 5.5V, clock input is 24/48MHz.

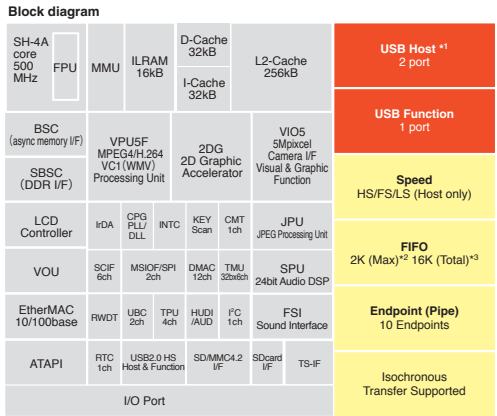
Hi-Speed USB2.0 Host and Function SH7780 Series

SH7724



The SH7724 is suitable for the One-segment supported PND and car navigation equipment. The playback and the video recording of HD are also realized.

The SH7724 (SH-MobileR2R) is a 32-bit RISC microprocessor with built-in USB Host and Function complying with Hi-Speed USB2.0 specifications. The SH7724 enables 500MHz operation that increasing the speed by approximately 1.3x of that of existing product "SH7723 (SH-MobileR2)", and it also improves the performance and functions for realizing the HD-compliant video playback and recording. 1-port USB host function and 1-port peripheral function can be operated at the same time by setting the register.

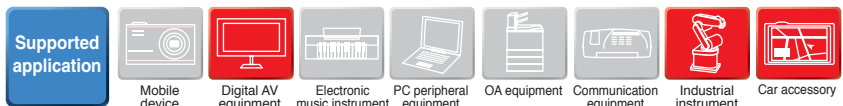


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R8A77240D500BG**	449	BGA	PRBG0449GA-A	64K (L1), 256K (L2)	16K	L	1.2/3.0 to 3.6, 1.8	-40 to 85	500
R8A77240B500BB**	441	BGA (POP supported)	PVBG0441KA-B			L		-20 to 70	

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
**★: Under development
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*3. Total number of built-in FIFO.

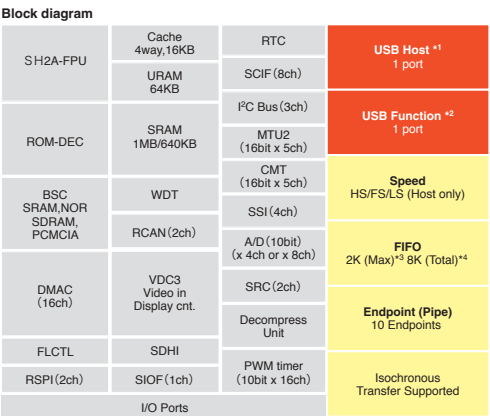
Hi-Speed USB2.0 Host and Function SH7260 Series

SH7262/SH7264



The SH7262/7264 is embedded with high-capacity SRAM, Hi-speed USB controller and video display controller. It is suitable for audio equipment, graphic dashboard equipment and OA/ industrial instrument.

The SH7262/7264 is a 32-bit RISC microprocessor embedded with USB Host and Function conforming to Hi-Speed USB2.0 specifications. It has FPU built-in high performance CPU core "SH2A-FPU" and the operation is available at up to a maximum operation frequency of 144MHz. The compressing and expanding processing of audio data such as MP3, WMA and AAC, which is required for audio applications, can be realized in higher speed with smaller program size thanks to high signal processing performance and ROM code efficiency. The USB module supports all transfer types based on the USB2.0 specifications.

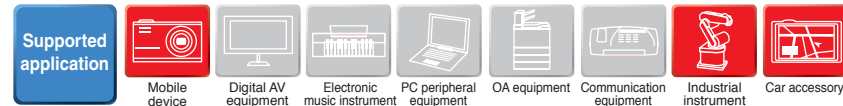
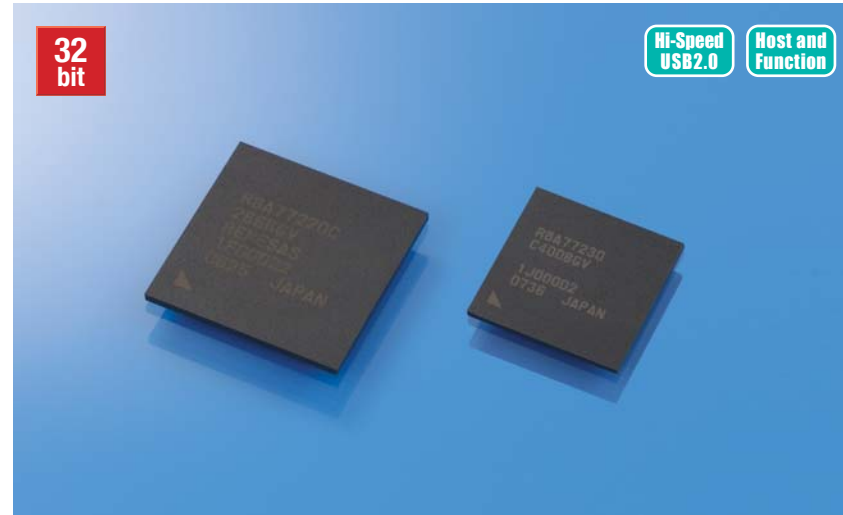


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)							
				Cache memory	RAM											
R5S72620P144FP**	176	QFP	PLQP0176KB-A	1088K	1088K	L	1.1 to 1.3/3.0 to 3.6	-40 to 85	144							
R5S72621P144FP**																
R5S72622P144FP**																
R5S72623P144FP**																
R5S72620W144FP**																
R5S72621W144FP**																
R5S72622W144FP**																
R5S72623W144FP**																
R5S72624P144FP**																
R5S72625P144FP**				704K							704K				-20 to 85	
R5S72626P144FP**																
R5S72627P144FP**																
R5S72624W144FP**																
R5S72625W144FP**																
R5S72626W144FP**																
R5S72627W144FP**																
R5S72640P144FP**																
R5S72641P144FP**																
R5S72642P144FP**	208	QFP	PLQP0208KB-A	1088K	1088K	L	1.1 to 1.3/3.0 to 3.6	-40 to 85	144							
R5S72643P144FP**																
R5S72644W144FP**																
R5S72641W144FP**																
R5S72642W144FP**																
R5S72643W144FP**																
R5S72644P144FP**																
R5S72645P144FP**																
R5S72646P144FP**																
R5S72647P144FP**				704K							704K				-20 to 85	
R5S72648P144FP**																
R5S72649P144FP**																
R5S72646W144FP**																
R5S72647W144FP**																
R5S72648W144FP**																
R5S72649W144FP**																
R5S72647W144FP**																
R5S72648W144FP**																

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
**★: Under development
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used.
*3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*4. Total number of built-in FIFO.

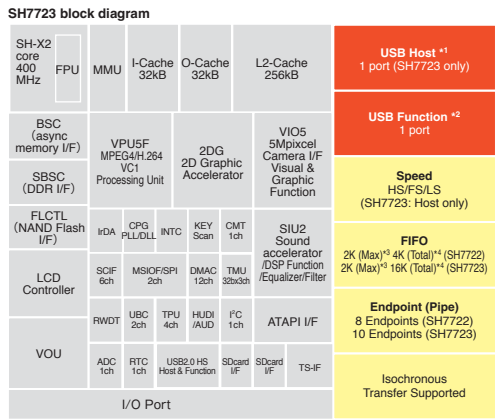
Hi-Speed USB2.0 Host and Function SH7780 Series

SH7722/SH7723



The SH7722 and SH7723 are suitable for multimedia equipment that requires high-end and low power at the same time such as One-segment supported car navigation equipment and portable media player.

The SH7722 (SH-MobileR) is a 32-bit RISC microprocessor embedded with a USB Function conforming to Hi-Speed USB2.0. The operation is available at up to 333MHz, as well as various multimedia support functions such as MPEG4-H.264, 2D graphic accelerator, LCD controller, camera interface and sound I/O. The SH7723 (SH-MobileR2) is a 32-bit RISC microprocessor embedded with a USB Host/Function conforming to Hi-Speed USB2.0. The operation is available at up to 400MHz. The SH7723 also has an FPU, the 256KB second cache and various multimedia support functions. The USB module supports all transfer types with USB2.0 specifications.

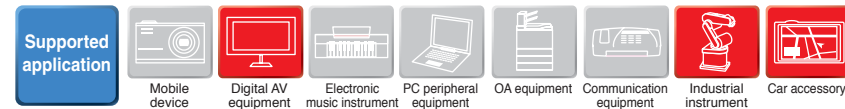
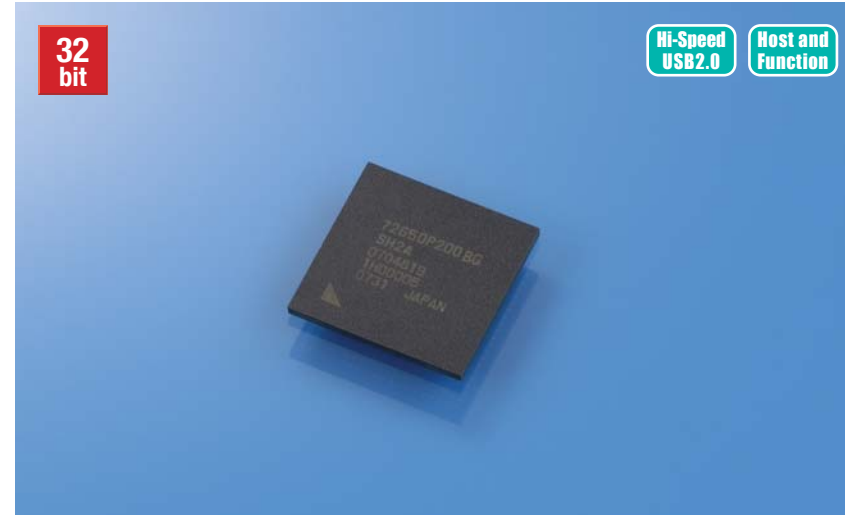


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R8A77220AC268BAV	449	BGA	PLBG0417KB-A	64K	148K	L	1.15 to 1.3/3.0 to 3.6	-20 to 70	266
R8A77220AC268BVG			PRBG0449GA-A			L	1.25 to 1.35/3.0 to 3.6	-40 to 85	333
R8A77230AC400BG*			64K (L1) 256K (L2)	16K	L	1.15 to 1.3/3.0 to 3.6	-20 to 70	400	
R8A77230AD400BG*	449	BGA	PRBG0449GA-A			L		-40 to 85	

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
**★: Under development
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO.

Hi-Speed USB2.0 Host and Function
SH7260 Series

SH7265/SH7205

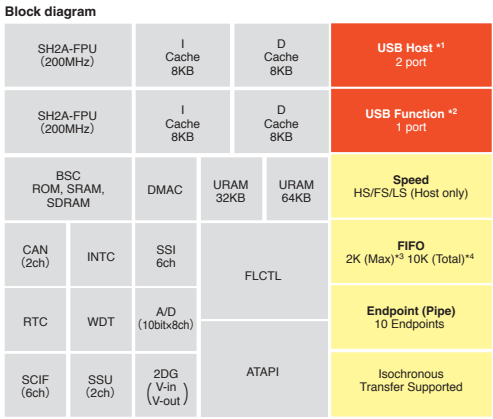


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5S72650P200BG★	272	BGA	PRBG0272GA-A	16K	112K	L	1.1 to 1.3/3.0 to 3.6	-40 to 85	200
R5S72651P200BG★									
R5S72652P200BG★									
R5S72653P200BG★									
R5S72050W200BG★									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version ★New product
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO.

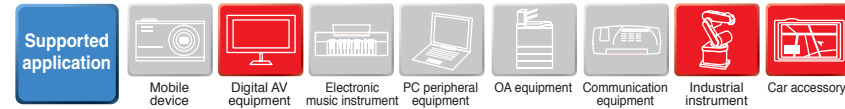
The SH7265 is suitable for the dissemination model of car audio, car navigation system and the products for multimedia equipment, and the SH7205 is suitable for the products of consumer equipment and industrial instrument.

The SH7265/7205 is a 32-bit RISC microprocessor embedded with 2 ports for a USB Host (2 ports) and Function conforming to Hi-Speed USB2.0 specifications. The SH7265/7205 is a multi-core microcontroller product with two built-in "SH2A-FPUs", and the operation is available at up to a maximum operation frequency of 200MHz. Since each core individually has FPU, the single SH7265/7205 product can operate data processing of industrial instruments or musical devices. In addition, it has various interfaces and peripheral functions. The USB module supports all transfer types based on the USB2.0 specifications with a 10KB FIFO that can be set at a maximum of 10 Endpoints.



Hi-Speed USB2.0 Host and Function
SH7260/SH7200 Series

SH7263/SH7203

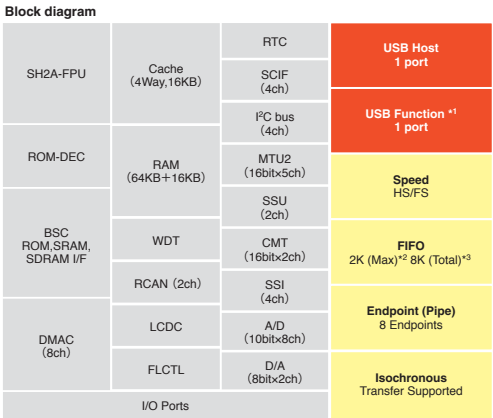


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5S72630P200FP	240	QFP	QFP3232-240Cu	16K	80K	L	1.1 to 1.3/3.0 to 3.6	-40 to 85	200
R5S72631P200FP									
R5S72632P200FP									
R5S72633P200FP									
R5S72030P200FP									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. When the Function is used, the Host cannot be used. *2. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *3. Total number of built-in FIFO.

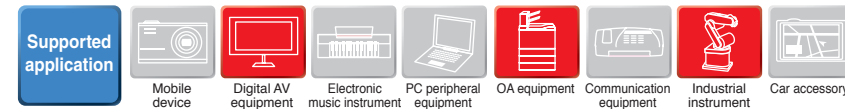
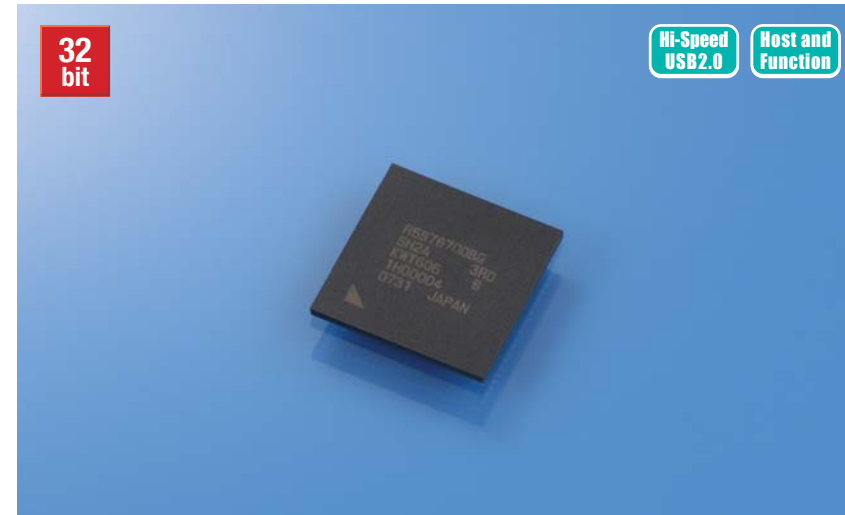
The SH7263 is suitable for the digital audio equipment such as car audio and home audio, and the SH7203 is suitable for the industrial instrument such as sequencer and robot.

The SH7263/SH7203 is a 32-bit RISC microprocessor embedded with USB Host and Function conforming to Hi-Speed USB2.0 specifications. In addition to the 200MHz "SH2A-FPU" core, 16KB cache memory and 80KB internal RAM, the device features abundant peripheral functions such as color LCDC, DMAC, audio interface, CDROM decoder and sampling rate converter. The USB module complies with all transfer types of USB2.0 specifications and is capable of setting the 8KB FIFO up to 8 Endpoints.



Hi-Speed USB2.0 Host and Function
SH-Ether Series

SH7670

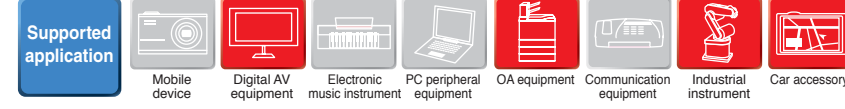
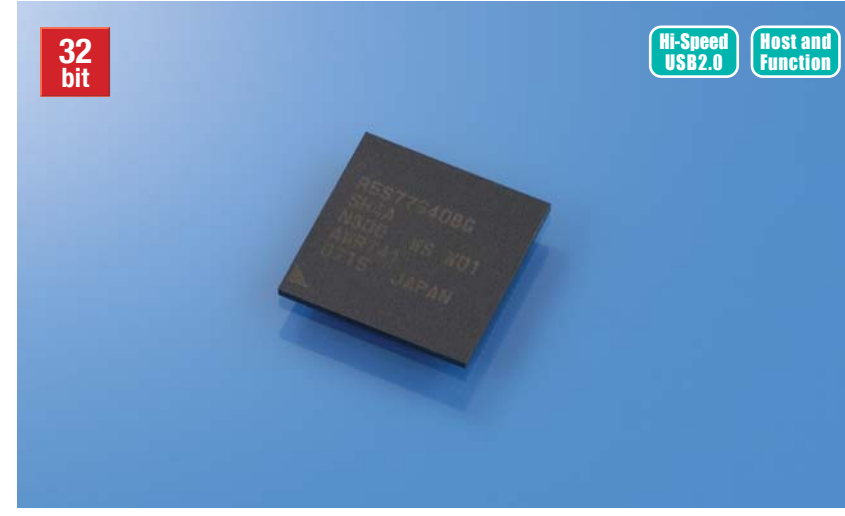


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5S76700B200BG	256	BGA	P-LFBGA1717-256	16K	32K	L	1.1 to 1.3/3.1 to 3.5	-20 to 70	200
R5S76710B200BG									
R5S76720B200BG									
R5S76730B200BG									
R5S76700D133BG									
R5S76710D133BG	256	BGA	P-LFBGA1717-256	16K	32K	L	1.1 to 1.3/3.1 to 3.5	-40 to 85	200
R5S76720D133BG									
R5S76730D133BG									
R5S76730D133BG									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO.

Hi-Speed USB2.0 Host and Function
SH7780 Series

SH7764

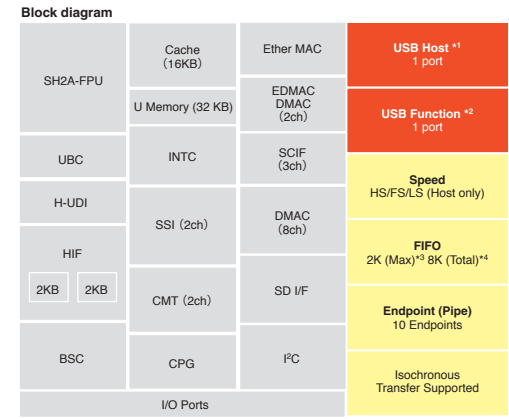


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5S77640N300BG★	404	BGA	PRBG0404GA-A	32KB+32KB	16K	L	1.15 to 1.35/3.0 to 3.6	-40 to 85	324
R5S77640P300BG★									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO.

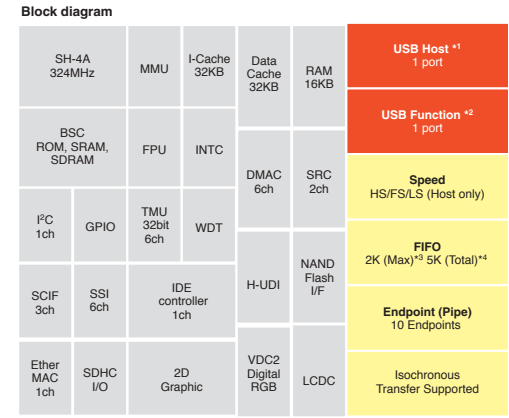
The SH7670 is suitable for the digital audio equipment such as DVD recorder, flat-screen television and audio compo and the industrial instrument such as sequencer and monitoring camera.

The SH7670 is a 32-bit RISC microprocessor embedded with USB Host and Function conforming to Hi-Speed USB2.0 specifications. It is embedded with 32-bit CPU core "SH2A-FPU" and realizes the high processing function of 480MIPS when the maximum operation frequency is 200MHz. In addition, the Ethernet controller, the host of USB2.0 and the Function are integrated in one chip for the first time in Renesas, so the LAN controller that has been required as an external part and LSI dedicated to USB2.0 can be reduced.



The SH7764 is suitable for the products for digital audio and multimedia applications such as home audio equipment and car navigation equipment.

The SH7764 is a high performance microprocessor embedded with USB Host and Function conforming to Hi-Speed USB2.0 specifications, and an FPU with "SH-4A" core. The operation is available at up to 324MHz. The CPU supports 583MIPS at maximum, and the FPU supports single precision and double-precision calculation, up to 2.3GFLOPS. The SH7764 allow high-speed processing of audio codec (WMA/MP3/AAC) and image data (2D/3D), and also, with hardware support for vector operation and sine/cosine operation, it allows high-speed 3D graphics processing. The USB module supports all transfer types based on the USB2.0 specifications with a 5KB FIFO that can be set at a maximum of 10 Endpoints.



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5S77640N300BG★	404	BGA	PRBG0404GA-A	32KB+32KB	16K	L	1.15 to 1.35/3.0 to 3.6	-40 to 85	324
R5S77640P300BG★									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. One stage of external HUB can be connected (for the Full-Speed function connection via Hi-Speed hub, the pay load of Iso. Transfer corresponds to 188 bytes or less.)
*2. When the Function is used, the Host cannot be used. *3. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *4. Total number of built-in FIFO.

Full-Speed USB2.0 Function
SH7216 Series

SH7216



Supported application

- Mobile device
- Digital AV equipment
- Electronic music instrument
- PC peripheral equipment
- OA equipment
- Communication equipment
- Industrial instrument
- Car accessory

The speed is increased from operation of our company's existing product SH7211 series at 160MHz to 200MHz to realize the improvement of performance by 1.25 times. In addition, 1MB large capacity flash memory and high-capacity RAM are incorporated.

With the SH7216 series, 32-bit CPU core "SH-2A" is embedded. The increase of consumption current due to speeding up is controlled by incorporating the power supply voltage reduction circuit and reducing the consumption current and the single supply operation at 3.3V is realized for high-speed operation at 200MHz. The peripheral function is embedded with PWM timer and 12-bit A/D converter, and Ethernet, USB and CAN are incorporated as a communication module.

Block diagram

SH2A-FPU	SCI(4ch) SCIF(1ch)	USB Function 1 port
BSC SRAM,NOR SDRAM	PC (1ch)	
DMAC (8ch)	MTU2 (16bit x 5ch)	Speed FS
DTC	MTU2S (16bit x 3ch)	FIFO 128 (Max)*1 288 (Total)*2
RAM 128KB/96KB/ 64KB	CMT (16bit x 2ch)	
EtherMAC (Option 1ch)	12bitA/D (4ch x 2Unit)	Endpoint (Pipe) 4 Endpoints
RSP1(1ch)	RCAN-ET (1ch)	Isochronous Transfer Not Supported
I/O Ports		

Full-Speed USB2.0 Function
SH7280 Series

SH7285/SH7286



Supported application

- Mobile device
- Digital AV equipment
- Electronic music instrument
- PC peripheral equipment
- OA equipment
- Communication equipment
- Industrial instrument
- Car accessory

The SH7285/7286 is embedded with abundant peripheral functions such as serial interface, multifunctional timer unit and 12-bit A/D converter. It is suitable for AC servo, general-purpose inverter and robot etc.

The SH7285/7286 is embedded with 32-bit CPU core "SH-2A" realizes the operation of a maximum of 100MHz and 200MIPS high-speed processing. It also has a built-in large-capacity flash memory (SH7286: up to 1MB, SH7285: up to 768KB). A newly embedded register bank allows high-speed register spilling at the time of interrupt, and significantly improves real time performance. Because the USB Function is based on USB2.0 and the USB standard commands and USB state are processed nearly fully automatically with hardware, the system development is simple.

Block diagram

SH-2A	RAM	MTU2	USB Function 1 port
UBC	Flash	MTU2S	
		DTC	Speed FS
H-UDI/AUD	SCI 4ch	WDT	FIFO 128 (Max)*1 288 (Total)*2
BSC	SCIF 1ch	PC	
DMAC (8ch)	SSU	CAN*	Endpoint (Pipe) 4 Endpoints
		D/A*	Isochronous Transfer Not Supported
I/O Ports			

Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
R5F72145BDFAA**	176	LQFP (20mm□)	PLQP0176LB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72146BDFAA**				768K	96K				
R5F72147BDFAA**				1M	128K				
R5F72145BDFPA**	176	LQFP (24mm□)	PLQP0176KB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72146BDFPA**				768K	96K				
R5F72147BDFPA**				1M	128K				
R5F72145BDBG**	176	BGA (13mm□)	PLBG0176GA-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72146BDBG**				768K	96K				
R5F72147BDBG**				1M	128K				
R5F72145ADFA**	176	LQFP (20mm□)	PLQP0176LB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72146ADFA**				768K	96K				
R5F72147ADFA**				1M	128K				
R5F72145ADFP**	176	LQFP (24mm□)	PLQP0176KB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72146ADFP**				768K	96K				
R5F72147ADFP**				1M	128K				
R5F72145ADBG**	176	BGA (13mm□)	PLBG0176GA-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72146ADBG**				768K	96K				
R5F72147ADBG**				1M	128K				
R5F72165BDFAA**	176	LQFP (20mm□)	PLQP0176LB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72166BDFAA**				768K	96K				
R5F72167BDFAA**				1M	128K				
R5F72165BDFPA**	176	LQFP (24mm□)	PLQP0176KB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72166BDFPA**				768K	96K				
R5F72167BDFPA**				1M	128K				
R5F72165BDBG**	176	BGA (13mm□)	PLBG0176GA-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72166BDBG**				768K	96K				
R5F72167BDBG**				1M	128K				
R5F72165ADFA**	176	LQFP (20mm□)	PLQP0176LB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72166ADFA**				768K	96K				
R5F72167ADFA**				1M	128K				
R5F72165ADFP**	176	LQFP (24mm□)	PLQP0176KB-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72166ADFP**				768K	96K				
R5F72167ADFP**				1M	128K				
R5F72165ADBG**	176	BGA (13mm□)	PLBG0176GA-A	512K	64K	F	3.0 to 3.6	-40 to 85	200
R5F72166ADBG**				768K	96K				
R5F72167ADBG**				1M	128K				

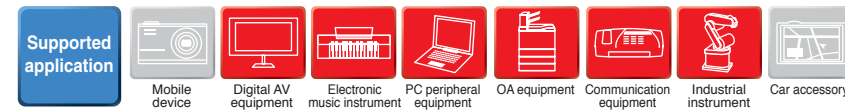
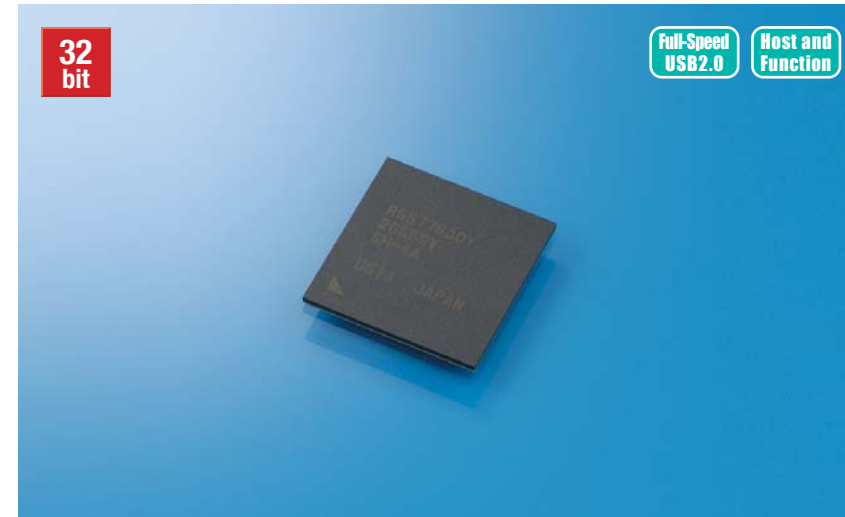
* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
**: Under development
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*2. Total number of built-in FIFO.

Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
R5F72855N100FP	144	LQFP	PLQP0144KA-A	512K	24K	F	3.0 to 3.6/4.5 to 5.5	-20 to 85	100
R5F72856N100FP				768K	32K				
R5F72856D100FP				768K	32K				
R5F72865N100FP	176	LQFP	PLQP0176KB-A	512K	24K	F	3.0 to 3.6/4.5 to 5.5	-20 to 85	100
R5F72865D100FP			PLQP0176LB-A						
R5F72865N100FA			PLQP0176KB-A	768K	32K				
R5F72865D100FA									
R5F72866N100FP			PLQP0176LB-A	768K	32K				
R5F72866D100FP									
R5F72866N100FA			PLQP0176KB-A	768K	32K				
R5F72866D100FA									
R5F72867N100FP			PLQP0176KB-A	1M	32K				
R5F72867D100FP									
R5F72867N100FA			PLQP0176LB-A	1M	32K				
R5F72867D100FA									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*2. Total number of built-in FIFO.
* SH7286 only

Full-Speed USB2.0 Function and OHCI1.0 Host
SH7700 Series

SH7763

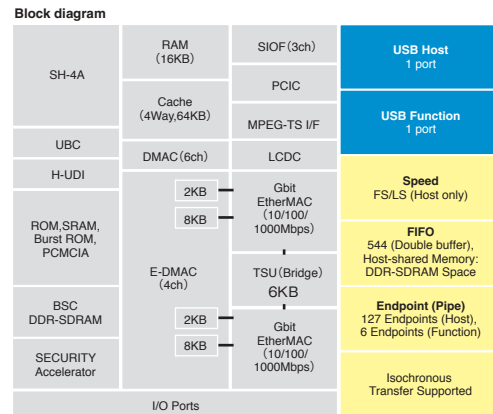


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5S77630AY266BGV	449	BGA	PRBG0449GA-A	64K	16K	L	1.15 to 1.35/3.0 to 3.6/2.3 to 2.7	-20 to 75	266
R5S77631AY266BGV	449	BGA	PRBG0449GA-A	64K	16K	L	1.15 to 1.35/3.0 to 3.6/2.3 to 2.7	-20 to 75	266
R5S77632AY266BGV	449	BGA	PRBG0449GA-A	64K	16K	L	1.15 to 1.35/3.0 to 3.6/2.3 to 2.7	-20 to 75	266

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version

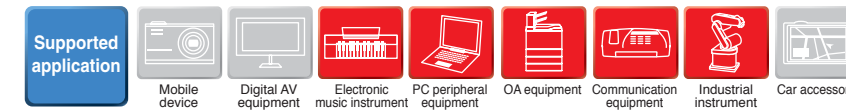
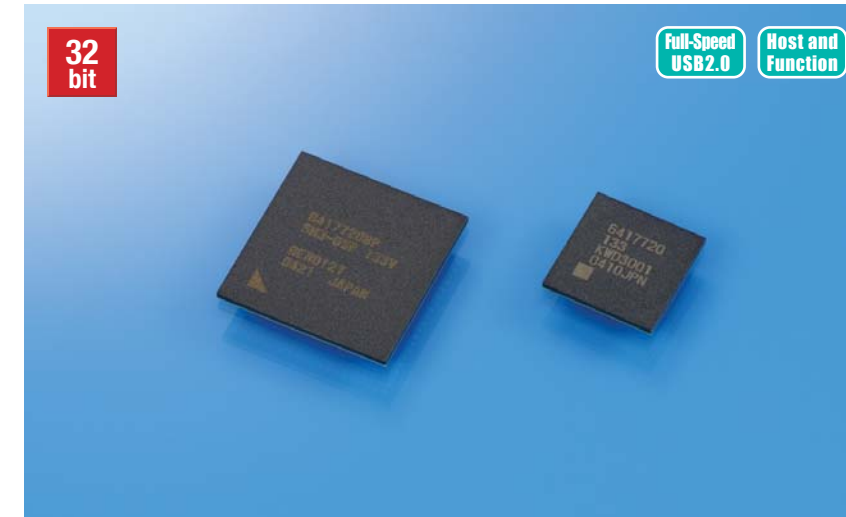
The SH7763 is embedded with various peripheral functions such as gigabit Ethernet controller, PCI bus controller, color LCD controller, security accelerator (can be selected with lineup), USB Host/Function (full speed). The SH7763 can support various systems and realizes the superior cost performance by selecting these functions as occasion demands.

The SH7763 adopts "SH-4A" core and is embedded with various peripheral functions such as gigabit Ethernet controller, PCI bus controller, color LCD controller, security accelerator (can be selected with lineup), USB Host/Function (full speed). The SH7763 can support various systems and realizes the superior cost performance by selecting these functions as occasion demands.



Full-Speed USB2.0 Function and OHCI1.0 Host
SH7700 Series

SH7720/SH7721

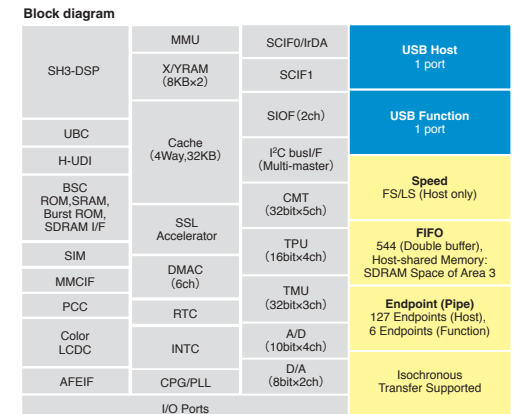


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
HD6417720BP133CV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
HD6417720BL133CV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
HD6417320BP133CV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
HD6417320BL133CV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
R8A77210C133BGV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
R8A77210C133BAV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
R8A77211C133BGV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
R8A77211C133BAV	256	CSP	PLBG0256GA-A	32K	16K	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version

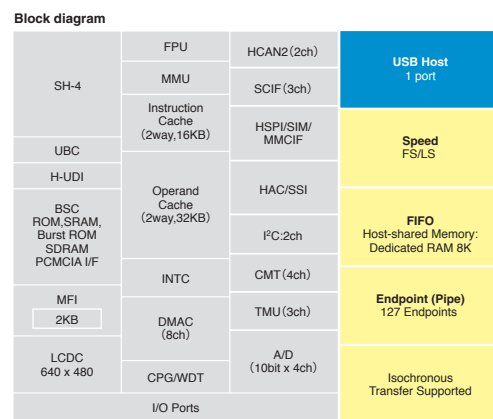
The SH7720/SH7721 is suitable for OA equipment, industrial instrument and mobile terminal thanks to abundant peripheral functions such as color LCD controller, USB, and the low power consumption.

The SH7720/SH7721 adopts "SH3-DSP" core and is embedded with abundant peripheral functions such as color LCD controller, SSL security accelerator (SH7720 only), USB Host / Function (full speed) and various card interfaces. These functions can realize the high-cost performance system and it can be applied to the mobile terminal by utilizing the low power consumption mode.



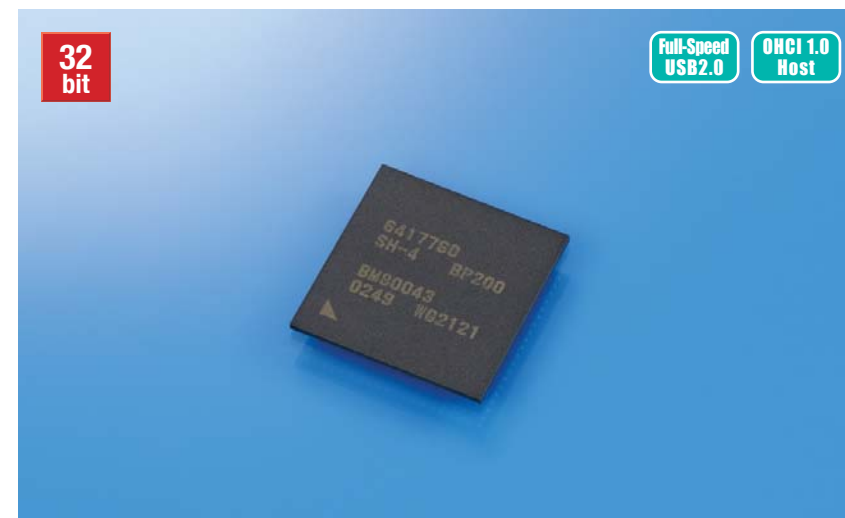
The SH7760 is suitable for the electronic equipment such as simple navigation system, POS terminal mounted on the color liquid crystal and audio equipment.

The SH7760 is a 32-bit RISC microprocessor embedded with USB Host with Low-Speed and Full-Speed OHCI1.0 specifications. In addition to the "SH-4" core with the highly efficient floating point arithmetic unit, 16KB instruction cache memory and 32KB data cache memory, the device features abundant peripheral functions such as 65536-color LCD, DMAC, UART with FIFO, audio interface, 32-bit automatic reloading timer, WDT. An external bus interface can control FLASH, SRAM, byte control SRAM and SDRAM.



Full-Speed USB (OHCI1.0 Host)
SH7750 Series

SH7760



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vdd/Vddq)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
HD6417760BL200ADV	256	BGA	PLBG0256GB-A	48K	—	L	1.4 to 1.6/3.0 to 3.6	-40 to 85	200
HD6417760BL200AV	256	BGA	PLBG0256GB-A	48K	—	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	200

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version

Full-Speed USB2.0 Function and OHCI1.0 Host
SH7700 Series

SH7727



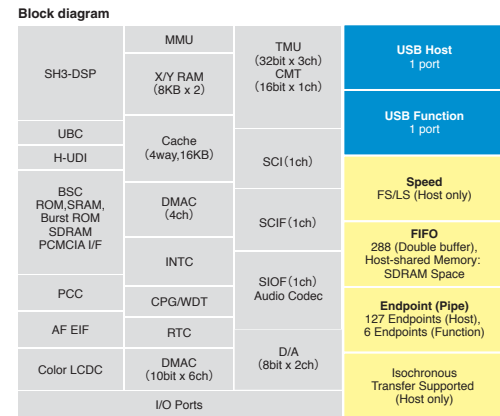
Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
HD6417727F160CV	240	HQFP	PRQP0240KC-B	16K	16K	L	1.75 to 2.05/3.0 to 3.6	-20 to 75	160
HD6417727F100CV				16K	16K	L	1.6 to 2.05/2.6 to 3.6	-20 to 75	100
HD6417727BP160CV	240	CSP	PLBG0240JA-A	16K	16K	L	1.75 to 2.05/3.0 to 3.6	-20 to 75	160
HD6417727BP100CV				16K	16K	L	1.6 to 2.05/2.6 to 3.6	-20 to 75	100

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version

The SH7727 is embedded with peripheral functions such as high-end SH3-DSP core, color LCD controller and USB.

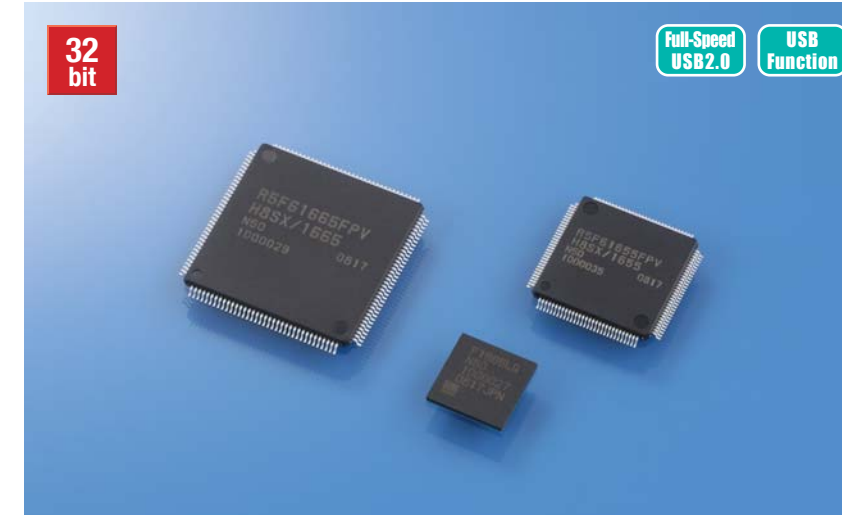
It is suitable for OA equipment and industrial instruments.

The SH7727 adopts "SH3-DSP" core and is embedded with peripheral functions such as color LCD controller, USB Host/Function (full speed). It is suitable for OA equipment and industrial instruments. The operation frequency can be selected from 160MHz and 100MHz, and the package type can be selected from HQFP and CSP.



Full-Speed USB2.0 Function
H8SX Family

H8SX/1665/1655 Group



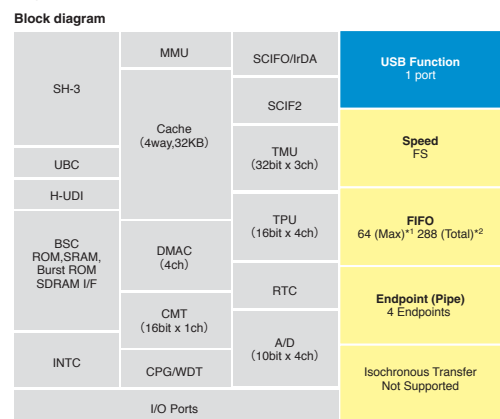
H8SX/1665 Group block diagram

H8SX-CPU @50MHz	ROM FLASH	RAM	USB Function 1 port
INTC	BSC SDRAM I/F added		Speed FS
TPU (16-bit timer) 6ch TPU (16-bit timer) 6ch PPG 16bit PPG 16bit	PLL TMR (8-bit timer): 8ch		
DMAC-4ch	WDT		FIFO 64 (Max) ^{*1} 288 (Total) ^{*2}
EXDMAC-4ch	DTC		
ADC10bit-4ch ADC10bit-4ch	DAC 10bit-2ch I/O Port		Endpoint (Pipe) 4 Endpoints
SCI-6ch	I ² C-2ch		
H-UDI	UBC		Isynchronous Transfer Not Supported
JTAG I/F	32KHz Sub-clock		

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*2. Total number of built-in FIFO.

The SH7705 is suitable for the mobile terminal that requires high-speed processing and low power consumption at the same time thanks to built-in strong power management function.

The SH7705 is embedded with abundant peripheral functions such as DMAC, serial interface, IrDA1.0, RTC and WDT in addition to high-end "SH-3" core and large-capacity cache memory of 32KB. The external bus interface can be directly connected to Flash, ROM, SRAM, byte-select SRAM, as well as 512Mbit large-capacity SDRAM. For the USB module, because the USB standard commands and USB state are processed nearly fully automatically with hardware, the system development is simple. With the bulk Endpoint engineered in a double-buffer mode, the high-speed transmission becomes a reality.



Full-Speed USB2.0 Function
SH7700 Series

SH7705

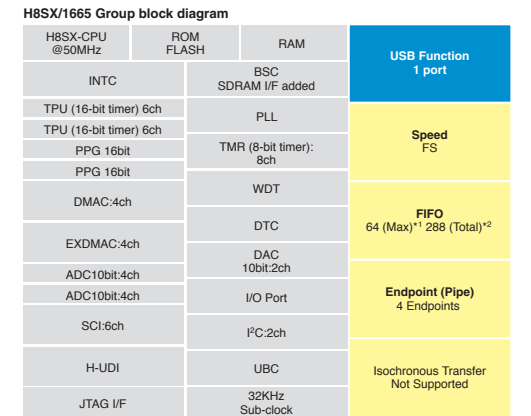


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (Vcc/VccQ)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
HD6417705F133B	208	LQFP	PLQP0208KA-A	32K	—	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
HD6417705F100B				32K	—	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	100
HD6417705BP133B	208	CSP	TTBG0208JA-A	32K	—	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	133
HD6417705BP100B				32K	—	L	1.4 to 1.6/3.0 to 3.6	-20 to 75	100

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. Total number of built-in FIFO.

The H8SX/1665/1655 Group offers the optimum solution to consumer, industrial and OA equipment. It can be also applied to POS terminal and IC card transaction terminal etc. in a combination with Secure IC.

The H8SX/1665/1655 Group mounts high-speed "H8SX CPU" core with a maximum operation frequency of 50MHz and incorporates 512KB/384KB large-capacity flash memory and 40KB RAM. This H8SX/1668/1658 product group offers pin function upward compatibility and peripheral functions such as high-speed 10bit-A/D and 10bitD/A, are strengthened. For the USB module, because the USB standard commands and USB state are processed nearly fully automatically with hardware, the system development is simple. Three types of transfer modes (Control, Bulk and Interrupt) are supported and with a bulk Endpoint engineered with a double buffer composition, the high-speed data transmission becomes a reality.



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
R5F61665* 50FPV★	144	LQFP	PLQP0144RA-A	512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61662* 50FPV★	144	LQFP	PLQP0144RA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61665* 50LPV★	145	LGA	PTLG0145JB-A	512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61662* 50LPV★	145	LGA	PTLG0145JB-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61655* 50FPV★	120	LQFP	PLQP0120LA-A	512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61652* 50FPV★	120	LQFP	PLQP0120LA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50

*: Clarifying quality grade ★: New product

Full-Speed USB2.0 Function
H8SX Family

H8SX/1668R/1668M Group H8SX/1658R/1658M Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
R5F61668R*50FPV	144	LQFP	PLQP0144KA-A	1M	56K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61668M*50FPV									
R5F61664R*50FPV	144	LQFP	PLQP0144KA-A	512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61664M*50FPV									
R5F61663R*50FPV	144	LQFP	PLQP0144KA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61663M*50FPV									
R5F61668R*50BGV	176	BGA	PLBG0176GA-A	1M	56K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61668M*50BGV									
R5F61664R*50BGV	176	BGA	PLBG0176GA-A	512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61664M*50BGV									
R5F61663R*50BGV	176	BGA	PLBG0176GA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61663M*50BGV									
R5F61658R*50FPV	120	LQFP	PLQP0120LA-A	1M	56K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61658M*50FPV									
R5F61654R*50FPV	120	LQFP	PLQP0120LA-A	512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61654M*50FPV									
R5F61653R*50FPV	120	LQFP	PLQP0120LA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61653M*50FPV									

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*2. Total number of built-in FIFO.

*: Clarifying quality grade

The H8SX/1668R/1668M Group incorporates low voltage detection circuit and power-on reset in addition to the functions of H8SX/1665/1655 Group. The usability has been improved to reduce the external parts.

The H8SX/1668R/1668M Group and the H8SX/1658R/1658M Group mount high-speed "H8SX CPU" core with 50MHz maximum operation frequencies and incorporate the 1MB/512KB/384KB large-capacity flash memory and 56KB/40KB RAM. This H8SX/1663/1653 product Group offers pin function upward compatibility and peripheral functions such as AD, TPU and EXDMAC, are strengthened. In addition, H8SX/1668M and H8SX/1658M have an LVD/POR function that allows the reduction of external parts. The system development is simple and allows the USB module to process USB standard commands and virtually automatic USB state using the hardware. Three types of transfer modes (Control, Bulk and Interrupt) are supported and with a bulk Endpoint engineered with a double buffer composition, the high-speed data transmission becomes a reality.

H8SX/1665 Group block diagram

H8SX-CPU @50MHz	ROM FLASH	RAM	USB Function 1 port
INTC	BSC	SDRAM I/F added	Speed FS
TPU (16-bit timer) 6ch	PLL		
TPU (16-bit timer) 6ch	TMR (8-bit timer): 8ch		FIFO 64 (Max)*1 288 (Total)*2
PPG 16bit	WDT		
PPG 16bit	DTC		Endpoint (Pipe) 4 Endpoints
DMAC:4ch	DAC 10bit:2ch		
EXDMAC:4ch	I/O Port		Isochronous Transfer Not Supported
ADC10bit:4ch	PC:2ch		
ADC10bit:4ch	UBC		
SCI:6ch	32KHz Sub-clock		
H-UDI			
JTAG I/F			

Full-Speed USB2.0 Function
H8SX Family

H8SX/1653/1663 Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				Cache memory	RAM				
R5F61653*50FTV	120	LQFP	PTQP0120LA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61654*50FTV				512K	40K				
R5F61664*50FPV	144	LQFP	PLQP0144KA-A	384K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	50
R5F61663*50FPV				512K	40K				

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. Total number of built-in FIFO.

*: Clarifying quality grade

The H8SX/1653/1663 Group incorporates abundant peripheral functions such as high-end H8SX CPU core and USB communications in a compact package. The USB communications with PC and the system control are balances.

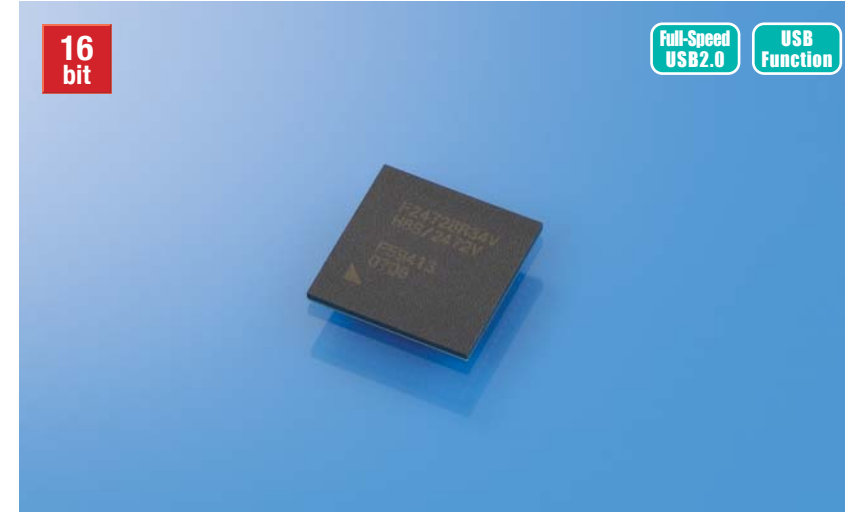
The H8SX/1653/1663 Group mounts a high-speed "H8SX CPU" core with 50MHz maximum operation frequencies and incorporates 512K/384KB large-capacity flash memory and 40KB RAM. This H8SX/1653/1663 product group offers abundant peripheral functions such as data transfer function, SCI (Smart Card I/F, supporting High-Speed SCI), timer, A/D, D/A. The system development is simple and allows the USB module to process USB standard commands and virtually automatic USB state using the hardware. Three types of transfer modes (Control, Bulk and Interrupt) are supported and with a bulk Endpoint engineered with a double buffer composition, the high-speed data transmission becomes a reality.

Block diagram

H8SX-CPU @50MHz	ROM FLASH	RAM	Clock Oscillator	USB Function 1 port
INTC	BSC	SDRAM I/F added		Speed FS
TPU (16-bit timer) 6ch	PLL			
PPG	TMR (8-bit timer): 8ch			FIFO 64 (Max)*1 288 (Total)*2
DMAC:4ch	WDT			
ADC 10bit:8ch	DTC			Endpoint (Pipe) 4 Endpoints
SCI:6ch	DAC 8bit:2ch			
H-UDI	I/O Port			Isochronous Transfer Not Supported
	PC:2ch			
	32KHz Sub-clock			

Full-Speed USB2.0 Function
H8S Family

H8S/2472 Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
R4F2472VBR*V	176	BGA	PLBG0176GA-A	ROM	RAM				
				512K	40K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	34

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version

*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. Total number of built-in FIFO.

*: Clarifying quality grade

The H8S/2472 Group is a single chip MCU with built-in Flash/RAM, which realizes Ether communications. It can be applied as a gateway of Ethernet and USB.

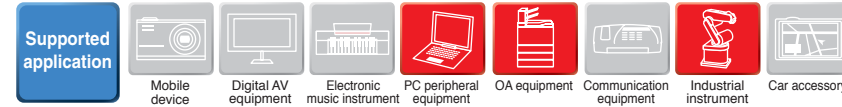
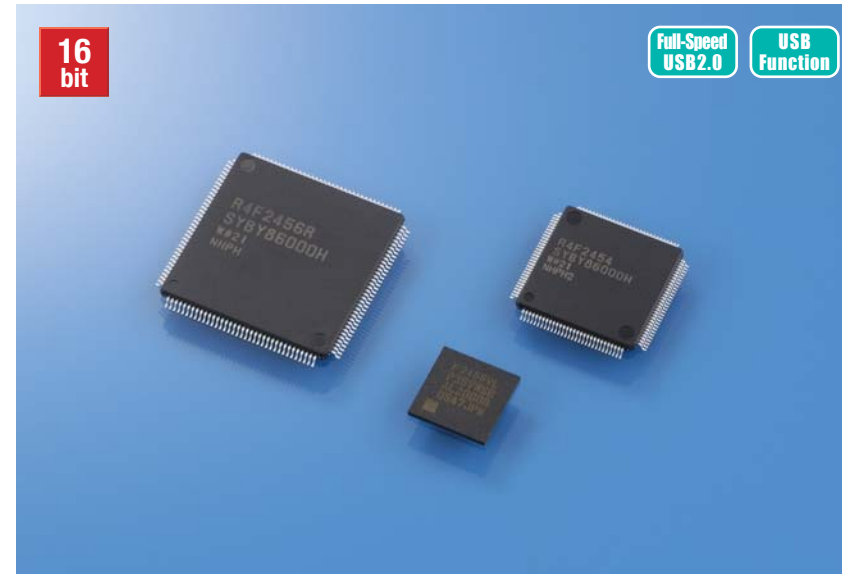
The H8S/2472 Group is embedded with high-speed CPU with 34MHz (at four times greater than 8.5MHz) operation, 512KB large-capacity flash memory and 40KB RAM. The system development is simple and allows the USB module to process USB standard commands and virtually automatic USB state using the hardware. Three types of transfer modes (Control, Bulk and Interrupt) are supported and with a bulk Endpoint engineered with a double buffer composition, the high-speed data transmission becomes a reality. The on-chip emulator E10A-USB conforming to JTAGI/F is also prepared to provide the development with a cheaper development tool.

Block diagram

H8S-CPU	Clock Oscillator	ROM	RAM	USB Function 1 port
BSC		INTC		Speed FS
Multiplier		TMR (16-bit timer): 12ch		
CRC calculation circuit		TMR (8-bit timer): 2ch		FIFO 64 (Max)*1 288 (Total)*2
DTC		14-bit PWM Timer: 4ch		
SCI:2ch		WDT:2ch		Endpoint (Pipe) 4 Endpoints
SCI with FIFO: 1ch		PC-Bus:6ch		
Synchronous Serial Communication Unit: 1ch		EtherC		Isochronous Transfer Not Supported
A/D 10bit:8ch		LPC		
Boundary scan		I/O port		
PLL				

Full-Speed USB2.0 Function
H8S Family

H8S/2456R/2456/2454 Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
R4F24569*VRFQV★	144	LQFP	PLQP0144KA-A	256K	64K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	32
R4F24568*VRFQV★				256K	48K	F			
R4F24565*VRFQV★				128K	48K	F			
R4S24562*VRFQV★				—	64K	L			
R4S24561*VRFQV★	144	LQFP	PLQP0144KA-A	—	48K	L	3.0 to 3.6	-20 to 75 (-40 to 85)	32
R4F24569*VFQV★				256K	64K	F			
R4F24568*VFQV★				256K	48K	F			
R4F24565*VFQV★				128K	48K	F			
R4S24562*VFQV★	120	LQFP	PLQ0120LA-A	—	64K	L	3.0 to 3.6	-20 to 75 (-40 to 85)	32
R4S24561*VFQV★				—	48K	L			
R4F24549*VFPV★				256K	64K	F			
R4F24548*VFPV★				256K	48K	F			
R4F24545*VFPV★	120	LQFP	PLQ0120LA-A	128K	64K	F	3.0 to 3.6	-20 to 75 (-40 to 85)	32
R4S24542*VFPV★				—	64K	L			
R4S24541*VFPV★				—	48K	L			

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
 *1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
 *2. Total number of built-in FIFO.
 *: Clarifying quality grade ★: New product

The H8S/2456R/2456/2454 Group can be applied to various applications of consumer, industrial and OA equipment thanks to multichannel serial interface and timer unit.

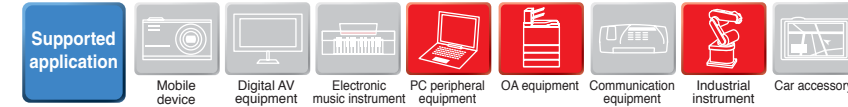
In addition to the high-speed 32MHz (double speed of 16MHz) CPU, 256KB flash memory and 64KB RAM, the H8S/2456R/2456/2454 Group is embedded with abundant peripheral functions such as serial interface (Smart Card I/F), I2C bus, 16-bit timer, 8-bit timer and synchronous serial communication. The system development is simple and allows the USB module to process USB standard commands and virtually automatic USB state using the hardware. Three types of transfer modes (Control, Bulk and Interrupt) are supported and with a bulk Endpoint engineered with a double buffer composition, the high-speed data transmission becomes a reality. The E10A-USB on-chip emulator conforming to JTAG I/F is also prepared to provide the development with a cheaper development tool.

H8SS/2456R Group block diagram

H8S-CPU	Clock Oscillator	ROM	RAM	USB Function 1 port
BSC		INTC		Speed FS
Multiplier		WDT		
DMAC		SCI		FIFO 128 (Max)*1 312 (Total)*2
EXDMAC		PC-Bus:4ch		
DTC		A/D 10bit:8ch x 2 Unit		Endpoint (Pipe) 4 Endpoints
I/O port		D/A 8bit:2ch		
TPU (16-bit timer): 12ch		SSU		Isochronous Transfer Not Supported
PPG		H-UDI		
TMR (8-bit timer): 8ch				

Full-Speed USB2.0 Function
H8S Family

H8S/2212/2215/2218 Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
HD64F2212FP	64	LQFP	PLQP0064KC-A	128K	12K	F	3.0 to 3.6	-20 to 75 (-40 to 85)*	24
HD64F2211FP				64K	8K	F			
HD6432211 (***) FP				64K	8K	M			
HD6432210 (***) FP				32K	4K	M			
HD64F2215RTE	120	TQFP	PTQP0120LA-A	256K	20K	F	3.0 to 3.6	-20 to 75 (-40 to 85)*	24/48
HD64F2215TTE				256K	20K	F			
HD64F2215TE				256K	16K	F			
HD64F2215RBR				256K	20K	F			
HD64F2215TBR	112	P-LFBGA	PLBG0112GA-A	256K	20K	F	3.0 to 3.6	-20 to 75 (-40 to 85)*	24/48
HD64F2215BR				256K	16K	F			
HD6432215B (***) TE				128K	16K	M			
HD6432215C (***) TE				64K	8K	M			
HD6432215B (***) BR	112	P-LFBGA	PLBG0112GA-A	128K	16K	M	3.0 to 3.6	-20 to 75 (-40 to 85)*	16/48
HD6432215C (***) BR				64K	8K	M			
HD64F2218TF				128K	12K	F			
HD6432217 (***) TF				64K	8K	M			
HD64F2218BR	112	P-LFBG	PLBG0112GA-A	128K	12K	F	3.0 to 3.6	-20 to 75 (-40 to 85)*	24
HD6432217 (***) BR				64K	8K	M			

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
 *1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
 *2. Total number of built-in FIFO.
 *: Wide temperature type

The H8S/2212/2215/2218 Group is equipped with a strong communication function. The power management functions such as sleep mode and standby mode are incorporated and these groups are suitable for the mobile equipment that requires low power consumption at the same time.

In addition to high-speed CPU with 24MHz operation and 128KB/256KB large-capacity flash memory, the H8S/2212/2215/2218 Group is embedded with abundant peripheral functions such as DMAC, serial interface, 16-bit timer, RTC and WDT.

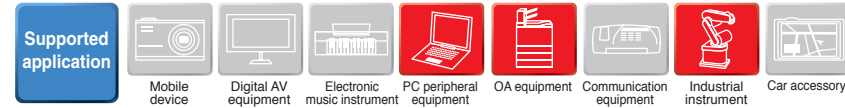
The system development is simple and allows the USB module to process USB standard commands and virtually automatic USB state using the hardware. Supports is furnished for 4 type (H8S/2215 Group) and 3-type (H8S/2212 and 2218 Groups) transfer modes, and because the bulk Endpoint (the H8S/2215 Group has isochronous support) is engineered with a double-buffer mode, the high-speed data transfer becomes a reality. Through USB, meanwhile, an onboard rewritable flash memory version is also available.

H8SS/2218 Group block diagram

H8S-CPU	Clock Oscillator	ROM	RAM	USB Function 1 port
BSC		INTC		Speed FS
DMAC		TPU (16-bit timer): 3ch		
SCI:2ch		WDT		FIFO 128 (Max)*1 456 (Total)*2 (2212, 2218) 256 (Max)*1 1288 (Total)*2 (2215)
A/D 10bit:6ch		INTC		
Boundary scan				Endpoint (Pipe) 4 Endpoints (2212, 2218), 9 Endpoints (2215)
H-UDI		I/O port	Sub-clock Oscillator	
				Isochronous Transfer Supported (2215 only)

Full-Speed USB2.0 Function
M16C/6C Series

M16C/6C Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
R5F36CAMNFB★	100	LQFP	PLQP0100KB-A	512K	31K	F	2.7 to 5.5	-20 to 85	32
R5F36CAMDFB★	100	LQFP	PLQP0100KB-A	512K	31K	F	2.7 to 5.5	-40 to 85	32
R5F36CAMNFA★	100	LQFP	PRQP0100JD-B	512K	31K	F	2.7 to 5.5	-20 to 85	32
R5F36CAMDFA★	100	LQFP	PRQP0100JD-B	512K	31K	F	2.7 to 5.5	-40 to 85	32
R5F36CAKNFB★	100	LQFP	PLQP0100KB-A	384K	31K	F	2.7 to 5.5	-20 to 85	32
R5F36CAKNFA★	100	LQFP	PRQP0100JD-B	384K	31K	F	2.7 to 5.5	-40 to 85	32
R5F36CAKDFB★	100	LQFP	PLQP0100KB-A	384K	31K	F	2.7 to 5.5	-20 to 85	32
R5F36CAKNFA★	100	LQFP	PRQP0100JD-B	384K	31K	F	2.7 to 5.5	-20 to 85	32
R5F36CAENFB★	100	LQFP	PLQP0100KB-A	256K	20K	F	2.7 to 5.5	-20 to 85	32
R5F36CAEDFB★	100	LQFP	PLQP0100KB-A	256K	20K	F	2.7 to 5.5	-40 to 85	32
R5F36CAENFA★	100	LQFP	PRQP0100JD-B	256K	20K	F	2.7 to 5.5	-20 to 85	32
R5F36CAEDFA★	100	LQFP	PRQP0100JD-B	256K	20K	F	2.7 to 5.5	-40 to 85	32
R5F36CA6NFB★	100	LQFP	PLQP0100KB-A	128K	12K	F	2.7 to 5.5	-20 to 85	32
R5F36CA6DFB★	100	LQFP	PLQP0100KB-A	128K	12K	F	2.7 to 5.5	-40 to 85	32
R5F36CA6NFA★	100	LQFP	PRQP0100JD-B	128K	12K	F	2.7 to 5.5	-20 to 85	32
R5F36CA6DFA★	100	LQFP	PRQP0100JD-B	128K	12K	F	2.7 to 5.5	-40 to 85	32

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*2. Total number of built-in FIFO.

★:New product

The M16C/6C Group mounts a high-end M16C CPU core to realize the highest 32MHz operation for M16C/60 series. Up to 512KB flash memory and 31KB RAM are incorporated.

The M16C/6C Group offers the compatibility with the M16C/6x Group. In addition to various peripheral functions, built-in two circuits of A/D converter and a 16-bit IC/OC timer have enriched the peripheral functions furthermore. The system development is simple and allows the USB module to process USB standard commands and virtually automatic USB state using the hardware. Three types of transfer modes (Control, Bulk and Interrupt) are supported and with a bulk Endpoint engineered with a double buffer composition, the high-speed data transmission becomes a reality. For the development environment, a single wire on-chip debugger E8a is available to make the development process simpler by a customer.

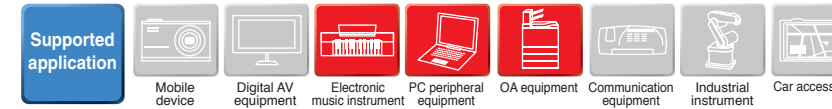
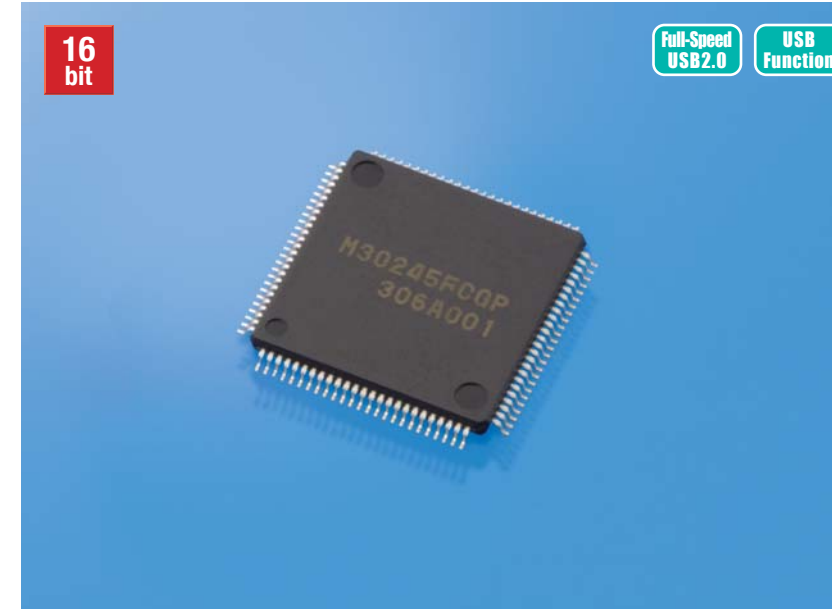
Block diagram

Component	Specification	USB Function
M16C/60 CPU Core	32MHz	1 port
PLL	OCO(125kHz)	Speed FS
Sub-clock	32kHz	
Multiplier	Timer A 5ch	FIFO 128 (Max)*1 584 (Total)*2
Interrupt	Timer B 6ch	
Flash Memory	CRC	Endpoint (Pipe) 7 Endpoints
RAM	10bit A/D x 2 26ch	
Data Flash	8bit D/A x 2ch	Isochronous Transfer Not Supported
User Boot	On-Chip-Debug	
LVD	OCO(40MHz)	
POR	Timer S	

88 I/O pins

Full-Speed USB2.0 Function
M16C/20 Series

M30245



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
M30245M8-XXXGP	100	LQFP	PTQP0100KB-A	64K	5K	M	3.0 to 3.6	-20 to 85	16
M30245MC-XXXGP	100	LQFP	PTQP0100KB-A	128K	10K	M	3.0 to 3.6	-20 to 85	16
M30245FCGP	100	LQFP	PTQP0100KB-A	128K	10K	F	3.0 to 3.6	-20 to 85	16

* F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode.
*2. Total number of built-in FIFO.

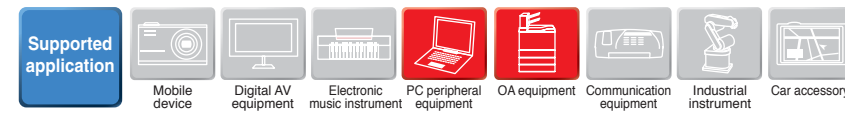
The M30245 Group is the M16C CPU core that supports isochronous Abundant peripheral functions such as audio interface and memory card interface are incorporated.

The M30245 (M16C/24 Group) consists of 16-bit single-chip MCUs with built in USB function control unit conforming to Full-Speed USB2.0 specifications. With "M16C CPU" embedded at the core, the M16C family is equipped with abundant peripheral functions and high-speed processing in addition to USB pull-up power source circuit, USB clock generator and various USB control functions. The addition of a multi-bit serial I/O enables an audio interface function, while the greater CRC calculating function enhances the memory card interface. In addition, other steps facilitating the audio application are implemented, making this system simple to configure for use in memory card application fields.

Block diagram

Component	Specification	USB Function
Power Source for USB Pull-up	D+ Pull-up Power Source (Supply Control)	1 port
Oscillation Circuit	2 circuits	Speed FS
DMA Controller	4ch	
A/D Converter	10-bit x 8ch	FIFO 1K (Max)*1 3.2K (Total)*2
Serial I/O	Multi-functional x 4ch	
Timer	Multi-functional 16-bit x 5	Endpoint (Pipe) 9 Endpoints
I/O Ports	Input: 1 Programmable I/O: 82	
Interrupt Factor	33	Isochronous Transfer Supported
External Memory	Memory Expansion Mode, Microprocessor Mode (Programmable-Wait Function)	
Minimum Instruction Execution Time	62.5ns	
PLL Frequency Multiplier	Built-in (USB48MHz generated internally)	
CRC Calculation Circuit	Selectable from 2 circuits (CRC-CCITT/CRC16)	
Watchdog Timer	1 channel	
Vbus Detector	USB cable connection/disconnection detector	
Pull-up I/O Port	80 (4-port unit)	

Full-Speed USB2.0 Function 38000Series 38K0 Group

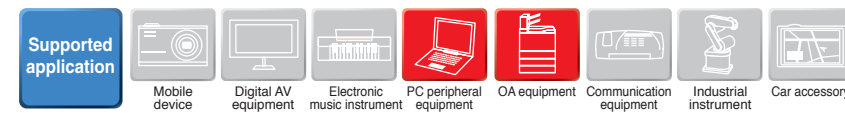


Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
M38K07M4L-XXXFP	64	LQFP	PLQP0064GA-A	16K	1K	M	3.00 to 5.25	-20 to 85	12 ^{*2}
M38K07M4L-XXXHP	64	LQFP	PLQP0064KB-A	16K	1K	M	3.00 to 5.25	-20 to 85	12 ^{*2}
M38K09F8LFP	64	LQFP	PLQP0064GA-A	32K	2K	F	3.00 to 5.25	-20 to 85	12 ^{*2}
M38K09F8LHP	64	LQFP	PLQP0064KB-A	32K	2K	F	3.00 to 5.25	-20 to 85	12 ^{*2}

*F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. This is the oscillation frequency that can be connected to external. For the internal clock, use 6MHz at 3V, and 6MHz or 8MHz at 5V.

Full-Speed USB2.0 Function and Hub 38000 Series

38K2 Group



Part Number	Pin	Package	Package Code	Memory capacity (Byte)		ROM Type*	Supply Voltage (V)	Operating Temperature (°C)	Clock (MHz)
				ROM	RAM				
M38K27M4L-XXXFP	64	LQFP	PLQP0064GA-A	16K	1K	M	3.00 to 5.25	-20 to 85	12 ^{*2}
M38K27M4L-XXXHP	64	LQFP	PLQP0064KB-A	16K	1K	M	3.00 to 5.25	-20 to 85	12 ^{*2}
M38K29F8LFP	64	LQFP	PLQP0064GA-A	32K	2K	F	3.00 to 5.25	-20 to 85	12 ^{*2}
M38K29F8LHP	64	LQFP	PLQP0064KB-A	32K	2K	F	3.00 to 5.25	-20 to 85	12 ^{*2}

*F: Flash memory version, L: ROM-less version, M: Mask ROM version, O: One-time PROM version
*1. The number of bytes settable for one pipe. The total doubles when using the double buffer mode. *2. This is the oscillation frequency that can be connected to external. For the internal clock, use 6MHz at 3V, and 6MHz or 8MHz at 5V.

The 38K0 Group is specialized for Bulk application with a small package.

It is suitable for one-chip USB converter with built-in serial I/O or bus interface.

The 38K0 Group consists of 8-bit single-chip MCUs with built-in USB functions in compliance with Full-Speed USB2.0. The built-in 4 endpoints, external bus interface×1, serial I/O×1, 8-bit timer×3 and A/D converter (8-channel) enable a variety of USB functions. In addition, 38K0 Group MCUs are suitable for USB conversion devices since the internal RAM can be accessed directly from USB and external interfaces.

Power Source for USB Pull-up	I/O Ports	USB Function
D+ Pull-up Power Source	48 (LED: 4)	1 port
Bus Interface	Pull-up I/O Port	Speed
8-bit×1 DMA Specification	10	FS
Serial I/O	Interrupt Factor	FIFO
UART/Clock Sync. 8-bit×1ch	15	USB Buffer Max 64 (Built-in RAM is used) *1
A/D Converter	Minimum Instruction Execution Time	Endpoint (Pipe)
10-bit×8ch	250ns	4 Endpoints
Timer	PLL Frequency Multiplier	Isynchronous Transfer Supported
8-bit×3 (with Prescaler)	Built-in (USB48MHz generated internally)	

Compound USB Hub of Hub + function
Abundant peripheral functions are embedded to realize Hub + function application equipment with one chip.

The 38K2 Group consists of 8-bit single-chip MCUs with built-in USB Hub + USB functions in compliance with Full-Speed USB2.0. The built-in down stream ports×2, 6 endpoints (USB functions: 4, USB Hub: 2), external bus interface×1, serial I/O×1, 8-bit timer×3 and A/D converter (8-channel) enable a variety of USB Hub + USB functions. In addition, 38K2 Group MCUs are suitable for USB conversion devices since the internal RAM can be accessed directly from USB and external interface.

Power Source for USB Pull-up	I/O Ports	USB Function + USB Hub
D+ Pull-up Power Source	44 (LED: 4)	1 port* (2-downstream port)
Bus Interface	Pull-up I/O Port	Speed
8-bit×1 DMA Specification	10	FS
Serial I/O	Interrupt Factor	FIFO
UART/Clock Sync. 8-bit×1ch	16	USB Buffer Max 64 (Built-in RAM is used) *1
A/D Converter	Minimum Instruction Execution Time	Endpoint (Pipe)
10-bit×8ch	250ns	2 Endpoints (Hub), 2 Endpoints (Function)
Timer	PLL Frequency Multiplier	Isynchronous Transfer Supported
8-bit×3 (with Prescaler)	Built-in (USB48MHz generated internally)	

USB2.0 Host USB Host-IP

USB Host-IP consists of OHCI Host-IP, EHCI Host-IP and Renesas original Host-IP, which is librarized Renesas USB ASSP. It is possible to choose a number of Endpoints and FIFO capacity according to the system.

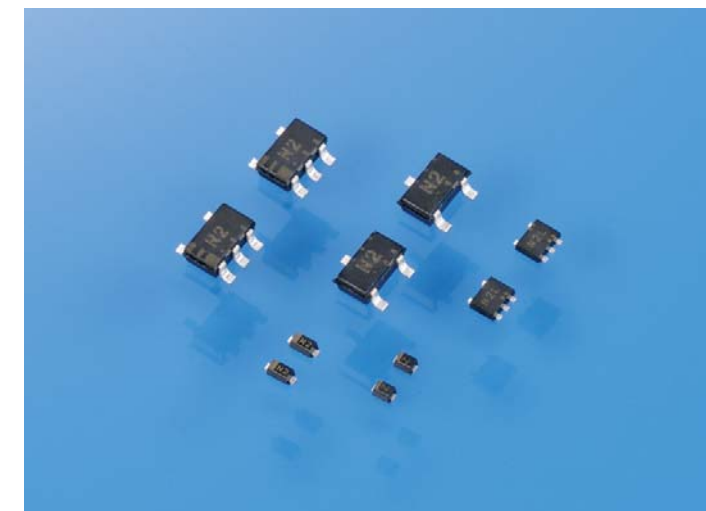
*1. It does not support High Band Width of Isochronous and Interrupt type.
One stage of an external HUB can be connected
(When the Full-Speed function is connected via Hi-Speed hub, the pay load of Isochronous corresponds to 188 bytes or less.)

USB2.0 Function USB-IP

USB-IP is librarized Renesas USB ASSP and consists of Full-Speed and Hi-Speed types. It is possible to choose a number of Endpoints and FIFO capacity according to the system.

USB2.0 (480 Mbps) supporting
low-capacitance surge absorption Zener diode

- HZM6.2/6.8Z4MFA (MPAK-5, 4 elements),
- HZM6.2/6.8Z4MWA (MPAK-3, 2 elements),
- RKZ6.2Z4MFAKT/RK6.8Z4KT (VSON-5; 4 elements),
- HZD6.2/6.8Z4 (SFP, 1 element),
- HZL6.2/6.8Z4 (EFP, 1 element)



Protecting an electric equipment and an electron device from ESD surge in a high-speed signal transmission path.

Electrical characteristics*2										
Item	Code	Test condition	6.2Z4 (6.2V)			6.8Z4 (6.8V)			Unit	
			Min.	Typ.	Max.	Min.	Typ.	Max.		
Zener voltage	Vz	Iz=5mA 40ms Pulse	5.9	—	6.5	6.47	—	7.0	V	
Reverse leak current	IR	VR=3.5V	—	—	—	—	—	2.0	μA	
		VR=5.5V	—	—	3.0	—	—	—	μA	
Junction capacitance	C	VR=0V f=1MHz	2.4 elements		—	4.0	4.5	—	4.0	pF
			1 elements		—	—	4.0	—	—	4.0
Dynamic resistance	Rd	Iz=5mA	—	—	60	—	—	30	Ω	
ESD*3	—	C=150pF R=330Ω 10 times forward and reverse impression	8	—	—	8	—	—	kV	

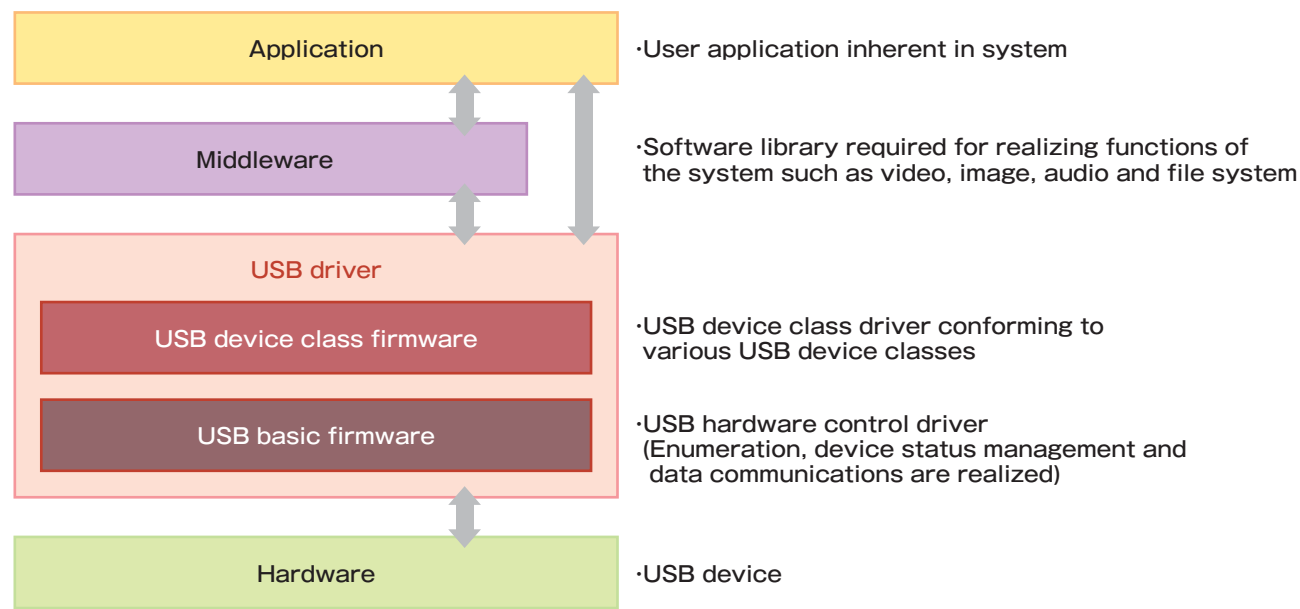
*2 Value per one element *3 Based on IEC61000-4-2 / Judgment with reverse leak current

USB Development / Evaluation Products

Renesas supports you build demo boards for the trial USB driver and for evaluation of your system development. With these demo boards added to your development environment, USB protocol control is no longer necessary. The end result easier and faster system development. They also strongly support our customers' USB system development through our agreements with partner vendors.

Layer configuration of USB driver

Outline of function



USB Driver Correspondence Table

Type name	Function					Host		
	USB basic firmware	HID	Mass Storage	Comm.	Printer	USB basic firmware	USB device class firmware	HID
SH7722	○*1						—	
SH7723	○*1					○*1		
SH7203/SH7263	○		*	*		○	○*1	
SH7205/SH7265	○		*	*		○	○*1	
SH7262/SH7264	○		*	*		○	△*1	
SH7670	○		*	*		○	△*1	
SH7285/SH7286	○*2		△	○				
SH7216	○*2	○	○	○	○		—	
SH7705	○*2		○	○	○			
SH7727	○*2		○	○	○			
SH7720	○*2		○	○	○			
SH7760			—			○		
SH7763	○*2		○	○	○	○		
H8SX/1653	○*2		○	○	○			
H8S/2456	○*2	○	○	○	○			
H8S/2472	○*2	○	○	○	○			
H8S/2212, H8S/2218	○*2	○	○	○	○			
H8S/2215	○*2	○	○	○	○			
M16C/6C	○*2	○	○	○	○		—	
M30245	○							
38K0,38K2	○							
M66291	○			○				
M66591	○							
M66592	○		△	△				
M66596/R8A66597	○*1 (M66596: OS-noncompliant version is also provided)		○*1			○*1 (M66596: OS-noncompliant version is also provided)	○*1	○*1 (R8A66597 only)
R8A66580	△ (USB, Wireless USB) *1					△ (USB) *1		

○: Sample (free of charge) ○: On sale △: Under development * : Under consideration —: N/A
 (Note) *1. Only OS-compliance version is provided. For the item without a mark (without *1), only OS-noncompliant version is provided. *2. USB Basic Firmware is included in each USB Device Class Firmware.

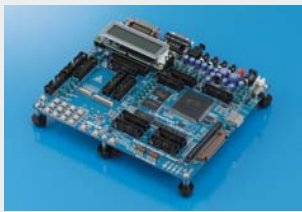
Memo

Demo Board/Evaluation Board

Hi-Speed MCU

POK572630D001BR <SH7263 Evaluation Board>

Equipped with hardware required to evaluate the SH7263 USB, LCDC, SSI and other functions of the SH7263. Standard embedding of USB interface, LCD module interface, audio interface, and other advantages and is suitable for advanced development of USB application products such as digital audio devices. In addition, all I/O ports of SH7263 are connected to the expansion connectors, enabling simple evaluation of peripheral functions and H/W expansion.



SH7722 Solution Engine

Evaluation board embedded with the H/W for evaluating the H.264/MPEG4 dynamic picture image, camera, USB, LCDC, SD Card, and other functions of SH7722. An environment where a main OS, such as a μ TRON or WindowsCE, can function and the on-chip debugger can connect as ready. It is also possible to use this as an easy program evaluation board in combination with a simple monitoring program. This board is a product of Hitachi ULSI Systems Co., Ltd.



Demo Board/Evaluation Board

Full-Speed MCU

SH7721 Solution Engine Light SH7727 Solution Engine Light

Evaluation board embedded with the H/W for evaluating built-in USB, LCDC, SIOF and other functions of SH7720 and SH7727. The environment where main OS such as μ TRON and the on-chip debugger connection run is ready. Connection with various USB ASSP utility boards (*1) is possible through relay board M3A-ZA53. It is also possible to use it as an easy program evaluation board in combination with a simple monitor program. This board is a product of Hitachi ULSI Systems Co., Ltd.



HSB8S2215RST <H8S/2215 Group Evaluation Board> HSB8S2215ST <H8S/2215 Group Evaluation Board> HSB8S2218ST <H8S/2218 Group Evaluation Board> HSB8S2212ST <H8S/2212 Group Evaluation Board>

These boards contain the H8S/2215, H8S/2218 and H8S/2212 group, and it is possible to use them as an easy program evaluation board in combination with a monitor program. Emulator connection is possible and the flash chip is loadable. In addition, the USB starter's kit is also available as an evaluation kit.



M3A-8K02 <38K0 Group/38K2 Group Evaluation, Development Board>

Evaluation/development board for the 38K0 Group and 38K2 Group. Embedded with circuits needed for USB function and USB hub, application of the external circuit use universal board (G04) facilitates simple development and evaluation of USB systems. Replacing the two-board set upper surface boards (G02, G03) makes it possible to conduct inspections with both flash-chips and debuggers. Since it is possible to exchange $V_{cc} = 5V/3.3V$, and USB rewriting/serial rewriting of flash memory with an easy switch, changes in peripheral setup can be performed in a short time.



HSB8SX1653F, HSB8SX1654F <H8SX/1653 Group Evaluation Board> HSB8SX1663F, HSB8SX1664F <H8SX/1663 Group Evaluation Board>

Evaluation board for CPUs equipped with the H8SX/1653 or 1663 Groups. Application as a program evaluation board by connecting a full emulator or an on-chip emulator. This board is a product of Hokuto Denshi Co., Ltd.



M3A-0245 <M16C/24 Group M30245 Evaluation Board>

Equipped with hardware required to evaluate USB and other peripherals functions of M30245. Loading of emulator connection or a flash-chip is possible. The board M3A-7754*1 for pitch conversion board can be connected and program rewriting of a flash-chip is easy. Moreover, since the connector which can be used to expand the universal board etc. is supported, the functional evaluation according to the use is possible. It can be used as an easy program evaluation board in combination with a simple monitor program. *1: Option



Demo Board / Evaluation Board

Full-Speed/Hi-Speed USB ASSP

M3A-0032 <M66291GP Utility Board>

A utility board embedded with the H/W required for M66291GP and USB communication. Two PCB connectors (13-pin x 2-line) are prepared for microprocessor connection. This connector is compatible with other Renesas USB ASSP utility boards, and is easily connectable to systems using Renesas USB ASSP. This comes equipped with a 12-MHz quartz-crystal oscillator, USB connector, test pin, and jumper SW for bus mode selection (expansion function of the M66291GP).



M3A-0037G01 <M66591GP Utility Board>

A Utility board equipped with the H/W required for M66591GP and USB communication, and including controlled D+/D- line impedance matching. Features two built-in PCB connectors (25-pin x 2-line) for MCU board and split bus connections. These connectors are compatible with other Renesas USB ASSP utility boards, and easily connectable to systems using Renesas USB ASSP. This comes equipped with a 24-MHz quartz-crystal oscillator, USB connector, test pin, and jumper SW for interface power supply change.



M3A-0038G01 <M66592FP Utility Board>

A utility board embedded with the H/W required for M66592FP and USB communication, and including controlled D+/D- line impedance matching. Features two built-in PCB connectors (25-pin x 2-line) for MCU board and split bus connections. These connectors are compatible with other Renesas USB ASSP utility boards, and easily connectable to systems using Renesas USB ASSP. This comes equipped with a 24-MHz quartz-crystal oscillator, USB connector, test pin, and jumper SW for interface power supply change.



M3A-0039 <M66596FP Utility Board>

A utility board embedded with the H/W required for M66596FP and USB communication, and including controlled D+/D- line impedance matching. Features two built-in PCB connectors (25-pin x 2-line) for MCU board and split bus connections. These connectors are compatible with other Renesas USB ASSP utility boards, and are easily connectable to systems using Renesas USB ASSP. This comes equipped with a 24-MHz quartz-crystal oscillator, USB connector, test pin, and jumper SW for interface power supply change.



M3A-0040 <R8A66597FP Utility Board>

A utility board embedded with the H/W required for R8A66597FP and USB communication and including controlled D+/D- line impedance matching. Features two built-in PCB connectors (25-pin x 2-line) for MCU board and split bus connections. These connectors are compatible with other Renesas USB ASSP utility boards, and are easily connectable to systems using Renesas USB ASSP. This comes equipped with a 24-MHz quartz-crystal oscillator, USB connector, test pin, and jumper SW for interface power supply change.



Demo Board / Evaluation Board

USB ASSP Evaluation Tool

M3A-0033 <Renesas USB ASSP Evaluation Motherboard>

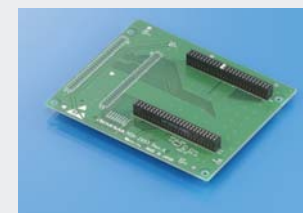
CPU board with a simple debugger embedded with M16C/80. By combining it with various USB ASSP utility boards (*1), all Renesas USB ASSP can easily be evaluated. It comes equipped with M16C/80, 10 MHz, a RS-232C driver, and interface connector for PC.



*1. Option: M3A-0037G01, M3A-0038G01, M3A-0039, M3A-0040
Bundle: M3A-0032

M3A-ZA53 <for SuperH Solution Engine> Converter Board for USB ASSP Utility Board

Relay board for evaluating Renesas USB ASSP from the SuperH Solution Engine™ using various USB ASSP utility boards (*1). It can be used in combination with the processor system Solution Engine™ (*2) and various USB ASSP utility boards.



*1. Option: M3A-0032, M3A-0037G01, M3A-0038G01, M3A-0039, M3A-0040
*2. Option: SH7727, SH7721



(An instance)

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